

DA9281

8 Channel System PMIC supporting DDR VTT

DA9281 is an 8-channel power management integrated circuit (PMIC) with 4 buck regulators, 3 LDOs and 1 voltage buffer to support DDR VTT termination.

Key functions for power applications, such as soft-start, selectable preset output voltage, flexible power-up and power-down sequences are provided on chip and are programmable via the I²C interface with non-volatile memory defaults.

All 8 channels have an output discharge function and protections features such as over-current protection (OCP), over voltage protection (OVP), and under voltage protection (UVP).

Key Features

- 4.5 V to 5.5 V input voltage
- BUCK (CH1 to CH4)
 - Output current 5.0 A at 0.8 to 3.0 V (CH1)
 - Output current 2.5 A at 0.8 to 3.3 V (CH2)
 - Output current 2.5 A at 0.8 to 3.6 V (CH3)
 - Output current 2.5 A at 0.8 to 3.3 V (CH4)
 - Operation frequency 2 MHz
 - Discharge function
 - Soft-start function
- LDO (CH6 to CH8)
 - Output current 0.2 A at 2.5 V (CH6)
 - Output current 0.2 A at 1.8/3.3 V (CH7)
 - Output current 1.6 A at 1.8 V (CH8)
 - Discharge function
 - Soft-start function
- Termination Voltage Regulator (CH5)
 - Output current -0.5 A to 0.5 A at CH4 = 1.2 V or CH4 = 1.35 V
 - Discharge function
 - Soft-start function
- I²C digital interface
- Protection features: OCP, OVP, UVP for all channels
- Parameters of output voltage can be changed by I²C control
- Programmable sequencer by I²C control
- -40 °C to +85 °C ambient temperature range
- QFN-40 5 mm x 5 mm 0.4 mm pitch package

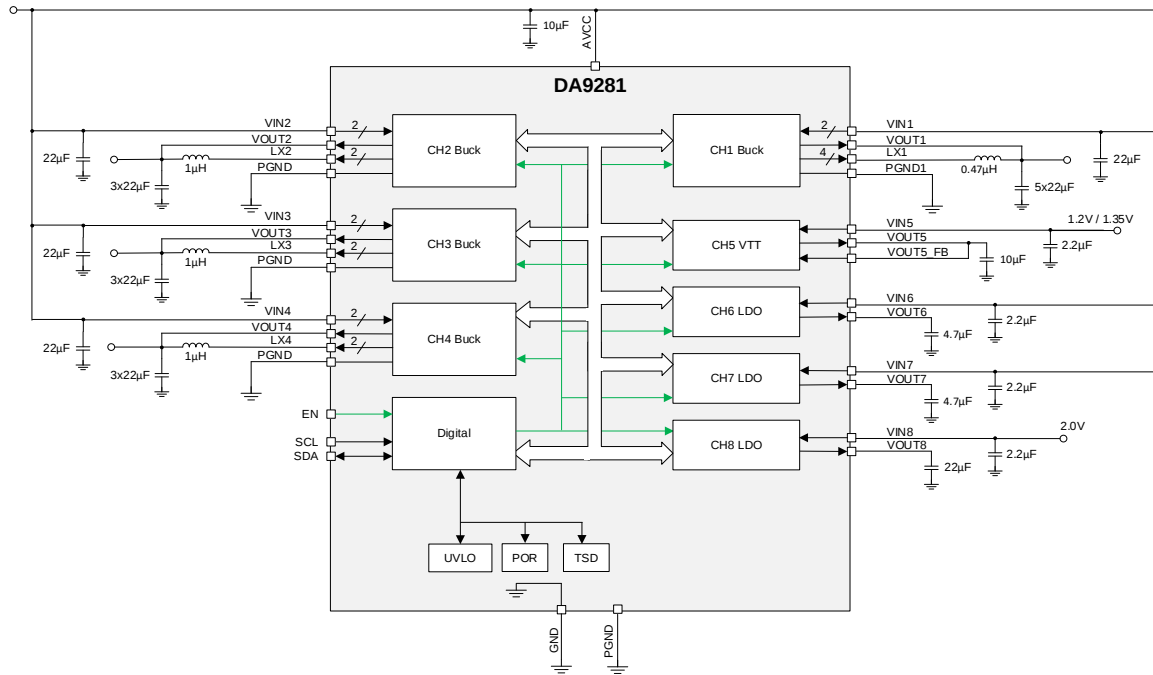


Figure 1. System Diagram

Contents

Key Features	1
Contents	3
Figures	4
Tables.....	5
1. Terms and Definitions	7
2. Overview	8
2.1 Block Diagram	8
3. Pin Information	9
3.1 Pin Assignments	9
3.2 Pin Descriptions.....	9
4. Specifications	11
4.1 Absolute Maximum Ratings	11
4.2 Recommended Operating Conditions	12
4.3 Electrical Characteristics	13
4.3.1 Current Consumption Characteristics	13
4.3.2 Supervisory Characteristics	14
4.3.3 CH1 Buck Converter Characteristics	15
4.3.4 CH2 Buck Converter Characteristics	17
4.3.5 CH3 Buck Converter Characteristics	19
4.3.6 CH4 Buck Converter Characteristics	21
4.3.7 CH5 Voltage Regulator Characteristics	23
4.3.8 CH6 LDO Characteristics	24
4.3.9 CH7 LDO Characteristics	25
4.3.10 CH8 LDO Characteristics	26
4.3.11 Digital I/O Characteristics.....	27
4.4 Timing Characteristics	28
5. Typical Performance Graphs.....	29
6. Functional Description	33
6.1 POWER_OFF, SHUTDOWN, OPERATING, UVLO, and Thermal Shutdown State Transitions.....	33
6.1.1 State Diagram	33
6.1.2 Mode Description	33
6.2 Startup and Shutdown Sequences	34
6.2.1 CH1, CH2, CH3, CH4 Soft Start-Up.....	34
6.2.2 Normal Startup Sequence.....	35
6.2.3 Normal Shutdown Sequence	36
6.2.4 UVLO Falling Shutdown	37
6.2.5 POR Falling Shutdown	39
6.2.6 TSD Thermal Shutdown Sequence.....	40
6.2.7 Restart Sequence POR Released	41
6.2.8 Restart Sequence TSD Released	42
6.3 Supervisory and Protection Functions.....	43

6.3.1	Under-Voltage Lockout	43
6.3.2	Thermal Shutdown	43
6.3.3	Over-Current Protection	43
6.3.4	Under-Voltage Protection	43
6.3.5	Over-Voltage Protection	43
6.3.6	DC-DC Latch Off Protection	44
6.3.7	LDO Latch Off Protection	44
6.3.8	UVP Behavior during Soft-Start	44
6.4	I ² C Communication	45
7.	Register Definitions	47
7.1	Register Map	47
7.2	Register Details	49
8.	Package Information	67
8.1	Package Outlines	67
8.2	Moisture Sensitivity Level	67
8.3	UQFN Handling	67
8.4	Soldering Information	67
9.	Ordering Information	68
10.	Application Information	69
10.1	Capacitor Selection	70
10.2	Inductor Selection	70
A.	ECAD Design Information	71
A.1	Part Number Indexing	71
A.2	Symbol Pin Information	71
A.2.1	40-QFN	71
A.3	Symbol Parameters	73
A.4	Footprint Design Information	74
A.4.1	40-QFN	74

Figures

Figure 1.	System Diagram	2
Figure 2.	Block Diagram	8
Figure 3.	40 Lead QFN 0.4 mm Pitch Package Pinout Diagram (Top View)	9
Figure 4.	CH1 Buck Efficiency	29
Figure 5.	CH2 Buck Efficiency	29
Figure 6.	CH3 Buck Efficiency	29
Figure 7.	CH4 Buck Efficiency	29
Figure 8.	CH1 Buck Load Regulation	29
Figure 9.	CH2 Buck Load Regulation	29
Figure 10.	CH3 Buck Load Regulation	30
Figure 11.	CH4 Buck Load Regulation	30
Figure 12.	CH1 Buck Line Regulation	30
Figure 13.	CH2 Buck Line Regulation	30
Figure 14.	CH3 Buck Line Regulation	30

Figure 15. CH4 Buck Line Regulation	30
Figure 16. CH1 Buck Minimum and Maximum Ripple	31
Figure 17. CH2 Buck Minimum and Maximum Ripple	31
Figure 18. CH3 Buck Minimum and Maximum Ripple	31
Figure 19. CH4 Buck Minimum and Maximum Ripple	31
Figure 20. CH5 Voltage Regulator Load Regulation	31
Figure 21. CH6 LDO Line Regulation ($V_{OUT} = 2.5\text{ V}$)	31
Figure 22. CH7 LDO Line Regulation ($V_{OUT} = 1.8\text{ V}, 3.3\text{ V}$)	32
Figure 23. CH8 LDO Line Regulation ($V_{OUT} = 1.8\text{ V}$)	32
Figure 24. State Transitions Diagram	33
Figure 25. Normal Startup Sequence	35
Figure 26. Normal Shutdown Sequence	36
Figure 27. UVLO Falling Shutdown Sequence 1	37
Figure 28. UVLO Falling Shutdown Sequence 2	38
Figure 29. POR Falling Shutdown	39
Figure 30. TSD Shutdown	40
Figure 31. Restart Sequence after POR Released	41
Figure 32. Restart Sequence after TSD Released	42
Figure 33. DC-DC Shutdown due to OCP/UVP	44
Figure 34. LDO Shutdown due to OCP/UVP	44
Figure 35. UVP Behavior during Soft-Start	45
Figure 36. I ² C Start (S) and Stop (P)	45
Figure 37. Single Write Command	46
Figure 38. Consecutive Write Command	46
Figure 39. Single Read Command	46
Figure 40. Consecutive Read Command	46
Figure 41. Application Diagram	69

Tables

Table 1. Pin Description	9
Table 2. Pin Type Definition	10
Table 3. Absolute Maximum Ratings	11
Table 4. Recommended Operating Conditions	12
Table 5. Current Consumption Characteristics	13
Table 6. Supervisory Characteristics	14
Table 7. CH1 Buck Converter Characteristics	15
Table 8. CH2 Buck Converter Characteristics	17
Table 9. CH3 Buck Converter Characteristics	19
Table 10. CH4 Buck Converter Characteristics	21
Table 11. CH5 Voltage Regulator Characteristics	23
Table 12. CH6 LDO Characteristics	24
Table 13. CH7 LDO Characteristics	25
Table 14. CH8 LDO Characteristics	26
Table 15. Digital I/O Electrical Characteristics	27
Table 16. I ² C Characteristics	28
Table 17. CH<x> Slew Rates	34
Table 18. Register Map	47

Table 19. Register Details	49
Table 21. MSL Classification	67
Table 22. Ordering Information.....	68
Table 23. Recommended Capacitor Types	70
Table 24. Recommended Inductor Types	70

1. Terms and Definitions

OCP	Over-current protection
OVP	Over-voltage protection
PMIC	Power management integrated circuit
POR	Power on reset
TSD	Thermal shutdown sequence
UVLO	Under-voltage lockout
UVP	Under-voltage protection
VTT	Termination voltage regulator

2. Overview

2.1 Block Diagram

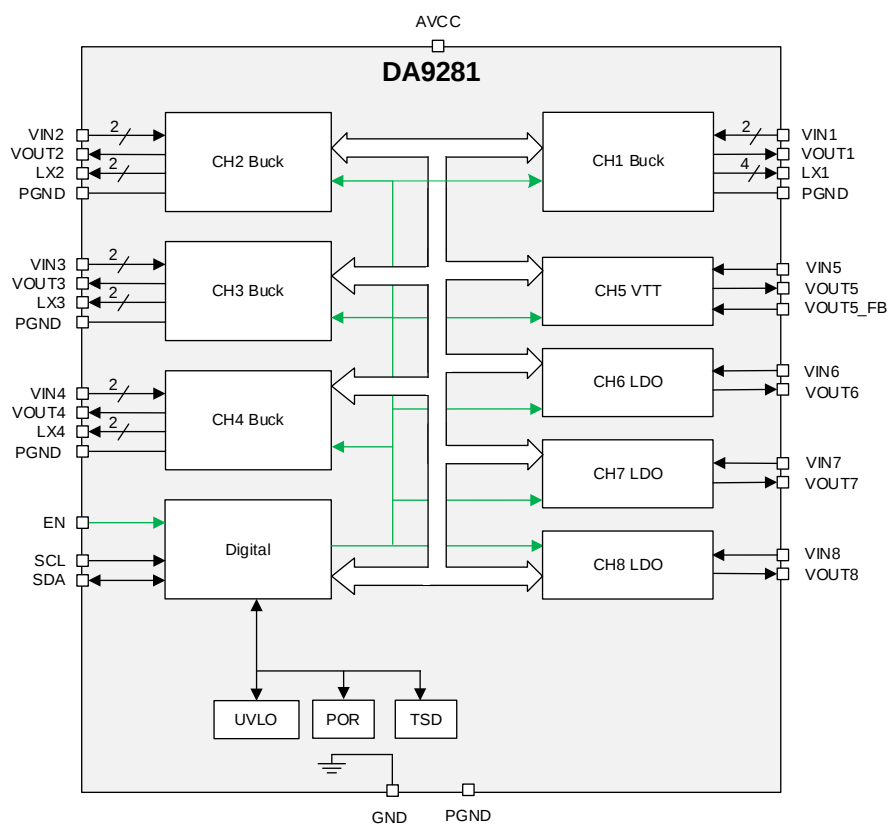


Figure 2. Block Diagram

3. Pin Information

3.1 Pin Assignments

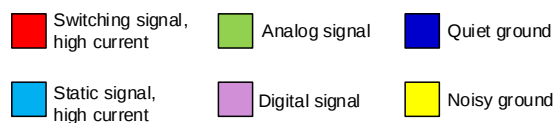
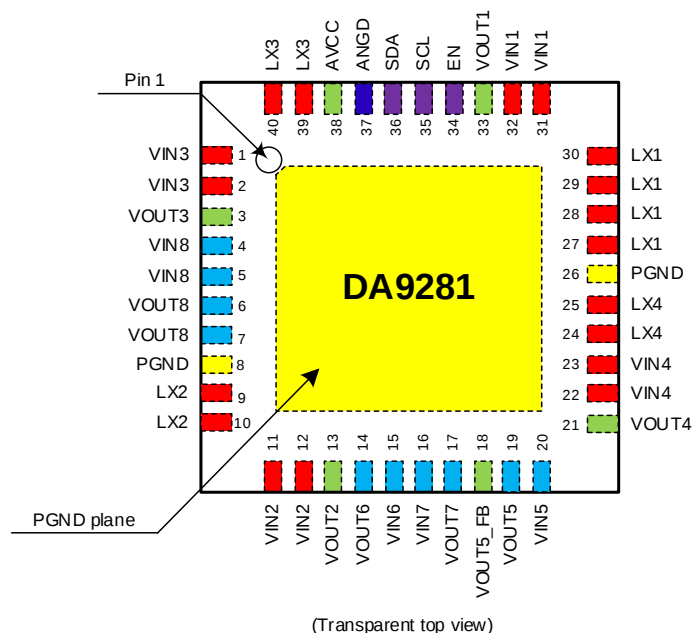


Figure 3. 40 Lead QFN 0.4 mm Pitch Package Pinout Diagram (Top View)

3.2 Pin Descriptions

Table 1. Pin Description

Pin Number	Pin Name	Type (Table 2)	Description
1,2	VIN3	PWR	Input voltage for CH3 buck converter
3	VOUT3	AI	Output voltage feedback of CH3 buck converter
4,5	VIN8	PWR	Input voltage for CH8 LDO
6,7	VOUT8	PWR	Output voltage of CH8 LDO
8	PGND	GND	Power ground
9,10	LX2	PWR	SW node of CH2 buck converter
11,12	VIN2	PWR	Input voltage for CH2 buck converter
13	VOUT2	AI	Output voltage feedback of CH2 buck converter
14	VOUT6	PWR	Output voltage of CH6 LDO
15	VIN6	PWR	Input voltage for CH6 LDO
16	VIN7	PWR	Input voltage for CH7 LDO
17	VOUT7	PWR	Output voltage of CH7 LDO
18	VOUT5_FB	AI	Output voltage feedback of CH5 regulator
19	VOUT5	PWR	Output voltage of CH5 regulator

Pin Number	Pin Name	Type (Table 2)	Description
20	VIN5	PWR	Input voltage for CH5 regulator
21	VOU4	AI	Output voltage feedback of CH4 buck converter
22,23	VIN4	PWR	Input voltage for CH4 buck converter
24,25	LX4	PWR	SW node of CH4 buck converter
26	PGND	GND	Power ground
27-30	LX1	PWR	SW node of CH1 buck converter
31,32	VIN1	PWR	Input voltage for CH1 buck converter
33	VOU1	AI	Output voltage feedback of CH1 buck converter
34	EN	DI	Enable pin
35	SCL	DI	2-wire I ² C clock
36	SDA	DIO	2-wire I ² C data input/output
37	AGND	GND	Quiet analog ground
38	AVCC	PWR	Quiet analog supply
39,40	LX3	PWR	SW node of CH3 buck converter
EPAD41	PGND	GND	Common ground for all channels

Table 2. Pin Type Definition

Pin Type	Description	Pin Type	Description
DI	Digital input	AI	Analog input
DIO	Digital input/output	GND	Ground
PWR	Power		

4. Specifications

4.1 Absolute Maximum Ratings

Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, so functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specification are not implied. Exposure to Absolute Maximum Rating conditions for extended periods may affect device reliability.

CAUTION: Do not operate at or near the maximum ratings listed for extended periods of time. Exposure to such conditions can adversely impact product reliability and result in failures not covered by warranty.

Table 3. Absolute Maximum Ratings

Parameter	Description	Conditions	Min	Max	Unit
T _{STG}	Storage temperature		-60	+150	°C
T _J	Junction temperature		-40	+150	°C
A _{VCC}	Power supply input		-0.3	6.0	V
V _{INX}	Power supply inputs		-0.3	V _{AVCC} + 0.3 Note 1	V
LX _X	SW node		-0.3	V _{INX} + 0.3 Note 2	V
V _{OUTX}	LDO output pins		-0.3	V _{INX} + 0.3 Note 2	V
SCL/SDA	Digital input pins		-0.3	6.0	V
	Max. input voltage	All other pins	-0.3	V _{AVCC} + 0.3 Note 1	V
	Max. power dissipation	T _A = 85°C		1.43	W
	Package thermal resistance		28		°C/W
	ESD tolerance	HBM		2	kV
	ESD tolerance	CDM		500	V

Note 1 Voltage must not exceed 6.0 V.

Note 2 Voltage must not exceed 6.0 V and must not exceed V_{AVCC} + 0.3 V.

4.2 Recommended Operating Conditions

Table 4. Recommended Operating Conditions

Parameter	Description	Conditions	Min	Typ	Max	Unit
T _A	Operating temperature		-40		+85	°C
T _J	Junction temperature		-40		-125	°C
V _{AVCC}	Supply voltage (AVCC)		4.5	5	5.5	V
V _{INX}	Supply voltages	X=1,2,3,4,6,7	4.5	5	5.5	V
V _{IN5}	Supply voltage (CH5)	V _{OUT4} = 1.2 V	1.176	1.2	1.224	V
		V _{OUT4} = 1.35 V	1.323	1.35	1.377	
V _{IN8}	Supply voltage (CH8)		1.98	2	2.12	V

4.3 Electrical Characteristics

4.3.1 Current Consumption Characteristics

Table 5. Current Consumption Characteristics

Parameter	Description	Conditions	Min	Typ	Max	Unit
Electrical performance						
$I_{VIN_AVCC_OFF}$	Current in OFF state (EN = LOW)	Total current from all VIN pins and AVCC pin $V_{AVCC} = 5\text{ V}$ $T_A = 85\text{ }^{\circ}\text{C}$ for maximum spec		20	50	μA
$I_{VIN_AVCC_ACTIVE}$	Current in ACTIVE state (EN = HIGH)	Total current from all VIN pins and AVCC pin No load, no switching $V_{AVCC} = 5\text{ V}$ $T_A = 85\text{ }^{\circ}\text{C}$ for maximum spec		600	2000	μA

4.3.2 Supervisory Characteristics

Table 6. Supervisory Characteristics

Parameter	Description	Conditions	Min	Typ	Max	Unit
Electrical performance						
Under-Voltage Lockout						
V _{UVLO_FALL}	UVLO falling threshold	At AVCC (Shutdown sequence is triggered)	3.7	3.8	3.9	V
V _{UVLO_HYS}	UVLO hysteresis	At AVCC	80	100	120	mV
V _{POR_FALL}	POR falling threshold	At AVCC (All channels are disabled immediately) Note 1	3.05		3.5	V
V _{DIGPOR_FALL}	Digital POR falling threshold	At AVCC (Digital Core Power-On-Reset)	2.5		3.05	V
V _{DIGPOR_HYS}	Digital POR hysteresis	At AVCC		175		mV
Under-Voltage Protection						
V _{UVP_FALL}	Under-voltage protection threshold	All channels	65	70	75	%
t _{UVP_DET}	UVP detect time			100		μs
Over-Voltage Protection						
V _{OVP_RISE}	Over-voltage protection threshold	All channels	115	120	125	%
t _{OVP_DET}	OVP detect time			100		μs
Thermal Shutdown						
T _{SHDN}	Thermal shutdown rising threshold			140	150	°C
T _{SHDN_HYS}	Thermal shutdown hysteresis			15		°C

Note 1 To ensure the proper operation of the power sequencer, AVDD must gradually rise through the V_{DIGPOR_FALL} threshold

4.3.3 CH1 Buck Converter Characteristics

Unless otherwise noted, the following is valid for $-40\text{ }^{\circ}\text{C} \leq T_A \leq +85\text{ }^{\circ}\text{C}$, $4.5\text{ V} \leq V_{IN1} \leq 5.5\text{ V}$.

Table 7. CH1 Buck Converter Characteristics

Parameter	Description	Conditions	Min	Typ	Max	Unit
External electrical conditions						
V_{IN1}	Input voltage	At VIN1 pin	4.5	5	5.5	V
C_{OUT}	Output Capacitance	Including voltage and temperature coefficient $5 \times 22\text{ }\mu\text{F}$	55	110	143	μF
ESR_{COUT}	ESR of C_{OUT}	$f > 100\text{ kHz}$ + track impedance			10	m Ω
L	Inductor value	Including current and temperature dependence	0.22	0.47	0.57	μH
ESR_{LBUCK}	Inductor resistance			23		m Ω
Electrical performance						
V_{OUT}	Output voltage	BUCK1 OPT CTRL6 = 0b 10 mV step	0.8		2.2	V
		BUCK1 OPT CTRL6 = 1b 20 mV step	1.6		3.0	V
V_{OUT_ACC}	Overall output accuracy	Including load and line regulation PWM operation	-2.5		2.5	%
$V_{OUT_ACC_PFM}$	Overall output accuracy	Including load and line regulation PFM operation	-2.5		4.5	%
V_{OUT_RPL}	Output voltage ripple	PWM operation	-10		10	mV
$V_{OUT_RPL_LLD}$	Output voltage ripple at light load	PFM operation	-25		25	mV
$V_{OUT_TR_LD_1500}$	Output voltage load transient Including DC accuracy	$I_{OUT} = 0.1\text{ to }1.5\text{ A}$ $di/dt = 0.5\text{ A}/\mu\text{s}$	-5		5	%
$V_{OUT_TR_LD_4500}$	Output voltage load transient Including DC accuracy	$I_{OUT} = 2.4\text{ to }4.5\text{ A}$ $di/dt = 0.5\text{ A}/\mu\text{s}$	-5		5	%
I_{OUT_MAX}	Maximum output current		5			A
$I_{POS LIM}$	Positive current limit			7		A
$I_{NEG LIM}$	Negative current limit			-2.4		A
f_{SW}	Switching frequency (PWM operation)		1.8	2	2.2	MHz
t_{EN_D}	Enable delay	Programmable in 800 μs steps	0		2.4	ms
t_{DIS_D}	Disable delay	Programmable	0		10	ms

Parameter	Description	Conditions	Min	Typ	Max	Unit
R _{PD_FB}	Feedback pull-down resistor	V _{OUT} = 0.5 V Disabled by OTP		15		Ω
η ₁₀₀	Efficiency	V _{IN1} = 5.0 V V _{OUT} = 0.8 V I _{OUT} = 10 mA to 100 mA Note 1		75		%
η ₃₀₀₀	Efficiency	V _{IN1} = 5.0 V V _{OUT} = 0.8 V I _{OUT} = 100 mA to 3 A		80		%
η ₄₀₀₀	Efficiency	V _{IN1} = 5.0 V V _{OUT} = 0.8 V I _{OUT} = 3 A to 4 A		75		%
H ₅₀₀₀	Efficiency	V _{IN1} = 5.0 V V _{OUT} = 0.8 V I _{OUT} = 4 A to 5 A		70		%

Note 1 V_{IN1} current only.

4.3.4 CH2 Buck Converter Characteristics

Unless otherwise noted, the following is valid for $-40\text{ }^{\circ}\text{C} \leq T_A \leq +85\text{ }^{\circ}\text{C}$, $4.5\text{ V} \leq V_{IN2} \leq 5.5\text{ V}$.

Table 8. CH2 Buck Converter Characteristics

Parameter	Description	Conditions	Min	Typ	Max	Unit
External electrical conditions						
V_{IN2}	Input voltage	At V_{IN2} pin	4.5	5	5.5	V
C_{OUT}	Output Capacitance	Including voltage and temperature coefficient 3 x 22 μF	33	66	85.8	μF
ESR_{COUT}	ESR of C_{OUT}	$f > 100\text{ kHz}$ + track impedance			10	$\text{m}\Omega$
L	Inductor value	Including current and temperature dependence	0.5	1	1.2	μH
ESR_{LBUCK}	Inductor resistance			40		$\text{m}\Omega$
Electrical performance						
V_{OUT}	Output voltage	BUCK2_OPT_CTRL6 = 0b 10 mV step	0.8		2.2	V
		BUCK2_OPT_CTRL6 = 1b 20 mV step	1.6		3.3	V
V_{OUT_ACC}	Overall output accuracy	Including load and line regulation PWM operation	-2		2	%
$V_{OUT_ACC_PFM}$	Overall output accuracy	Including load and line regulation PFM operation	-2		3.5	%
V_{OUT_RPL}	Output voltage ripple	PWM operation	-10		10	mV
$V_{OUT_RPL_LLD}$	Output voltage ripple at light load	PFM operation	-20		20	mV
$V_{OUT_TR_LD}$	Output voltage load transient	$I_{OUT} = 0.5\text{ to }2.5\text{ A}$ $dI/dt = 0.5\text{ A}/\mu\text{s}$ Including DC accuracy	-5		5	%
I_{OUT_MAX}	Maximum output current		2.5			A
I_{POSLIM}	Positive current limit			3.75		A
I_{NEGLIM}	Negative current limit			-1.4		A
f_{SW}	Switching frequency (PWM operation)		1.8	2	2.2	MHz
t_{EN_D}	Enable delay	Programmable in 800 μs steps	0		2.4	ms
t_{DIS_D}	Disable delay	Programmable	0		10	ms

Parameter	Description	Conditions	Min	Typ	Max	Unit
R _{PD_FB}	Feedback pull-down resistor	V _{OUT} = 0.5V Disabled by OTP		30		Ω
η ₁₀₀	Efficiency	V _{IN2} = 5.0 V V _{OUT} = 2.5 V I _{OUT} = 1 mA to 100 mA Note 1		90		%
η ₁₀₀₀	Efficiency	V _{IN2} = 5.0 V V _{OUT} = 2.5 V I _{OUT} = 100 mA to 1 A		90		%
η ₂₀₀₀	Efficiency	V _{IN2} = 5.0 V V _{OUT} = 2.5 V I _{OUT} = 1 A to 2 A		85		%
η ₂₅₀₀	Efficiency	V _{IN2} = 5.0 V V _{OUT} = 2.5 V I _{OUT} = 2 A to 2.5 A		85		%

Note 1 VIN2 current only

4.3.5 CH3 Buck Converter Characteristics

Unless otherwise noted, the following is valid for $-40\text{ }^{\circ}\text{C} \leq T_A \leq +85\text{ }^{\circ}\text{C}$, $4.5\text{ V} \leq V_{IN3} \leq 5.5\text{ V}$.

Table 9. CH3 Buck Converter Characteristics

Parameter	Description	Conditions	Min	Typ	Max	Unit
External electrical conditions						
V_{IN3}	Input voltage	At V_{IN3} pin	4.5	5	5.5	V
C_{OUT}	Output Capacitance	Including voltage and temperature coefficient $3 \times 22\text{ }\mu\text{F}$	33	66	85.8	μF
ESR_{COUT}	ESR of C_{OUT}	$f > 100\text{ kHz}$ + track impedance			10	m Ω
L	Inductor value	Including current and temperature dependence	0.5	1	1.2	μH
ESR_{LBUCK}	Inductor resistance			40		m Ω
Electrical performance						
V_{OUT}	Output voltage	BUCK3_OPT_CTRL6 = 0b 10 mV step	0.8		2.2	V
		BUCK3_OPT_CTRL6 = 1b 20 mV step	1.6		3.6	V
V_{OUT_ACC}	Overall output accuracy	Including load and line regulation PWM operation	-2		2	%
$V_{OUT_ACC_PFM}$	Overall output accuracy	Including load and line regulation PFM operation	-2		3.5	%
V_{OUT_RPL}	Output voltage ripple	PWM operation	-10		10	mV
$V_{OUT_RPL_LLD}$	Output voltage ripple at light load	PFM operation $V_{OUT} \leq 3.3\text{ V}$	-20		20	mV
$V_{OUT_TR_LD}$	Output voltage load transient	$V_{OUT} \leq 3.3\text{ V}$ $I_{OUT} = 0.5\text{ to }2.5\text{ A}$ $di/dt = 0.5\text{ A}/\mu\text{s}$ Including DC accuracy	-5		5	%
I_{OUT_MAX}	Maximum output current	$V_{OUT} \leq 3.3\text{ V}$	2.5			A
$I_{POS LIM}$	Positive current limit threshold			3.75		A
I_{NEGLIM}	Negative current limit			-1.4		A
f_{SW}	Switching frequency (PWM operation)		1.8	2	2.2	MHz
t_{EN_D}	Enable delay	Programmable in 800 μs steps	0		2.4	ms
t_{DIS_D}	Disable delay	Programmable	0		10	ms

Parameter	Description	Conditions	Min	Typ	Max	Unit
R _{PD_FB}	Feedback pull-down resistor	V _{OUT} = 0.5V Disabled by OTP		30		Ω
η ₁₀₀	Efficiency	V _{IN3} = 5.0 V V _{OUT} = 1.2 V I _{OUT} = 1 mA to 100 mA Note 1		85		%
η ₁₀₀₀	Efficiency	V _{IN3} = 5.0 V V _{OUT} = 1.2 V I _{OUT} = 100 mA to 1 A		85		%
η ₂₀₀₀	Efficiency	V _{IN3} = 5.0 V V _{OUT} = 1.2 V I _{OUT} = 1 A to 2 A		80		%
η ₂₅₀₀	Efficiency	V _{IN3} = 5.0 V V _{OUT} = 1.2 V I _{OUT} = 2 A to 2.5 A		75		%

Note 1 VIN3 current only

4.3.6 CH4 Buck Converter Characteristics

Unless otherwise noted, the following is valid for $-40\text{ }^{\circ}\text{C} \leq T_A \leq +85\text{ }^{\circ}\text{C}$, $4.5\text{ V} \leq V_{IN4} \leq 5.5\text{ V}$.

Table 10. CH4 Buck Converter Characteristics

Parameter	Description	Conditions	Min	Typ	Max	Unit
External electrical conditions						
V_{IN4}	Input voltage	At VIN4 pin	4.5	5	5.5	V
C_{OUT}	Output Capacitance	Including voltage and temperature coefficient 3 x 22 μF	33	66	85.8	μF
ESR_{COUT}	ESR of C_{OUT}	$f > 100\text{ kHz}$ + track impedance			10	m Ω
L	Inductor value	Including current and temperature dependence	0.5	1	1.2	μH
ESR_{LBUCK}	Inductor resistance			40		m Ω
Electrical performance						
V_{OUT}	Output voltage	BUCK4_OPT_CTRL6 = 0b 10 mV step	0.8		2.2	V
		BUCK4_OPT_CTRL6 = 1b 20 mV step	1.6		3.3	V
V_{OUT_ACC}	Overall output accuracy	Including load and line regulation PWM operation	-2		2	%
$V_{OUT_ACC_PFM}$	Overall output accuracy	Including load and line regulation PFM operation	-2		3.5	%
V_{OUT_RPL}	Output voltage ripple	PWM operation	-10		10	mV
$V_{OUT_RPL_LLD}$	Output voltage ripple at light load	PFM operation	-20		20	mV
$V_{OUT_TR_LD_2000}$	Output voltage transient load regulation	$I_{OUT} = 0.5\text{ A to }2.0\text{ A}$ $dI/dt = 0.5\text{ A}/\mu\text{s}$ Including DC accuracy	-5		5	%
I_{OUT_MAX}	Maximum output current		2.5			A
I_{POSLIM}	Positive current limit threshold			3.5		A
I_{NEGLIM}	Negative current limit			-1.4		A
f_{SW}	Switching frequency (PWM operation)		1.8	2	2.2	MHz
t_{EN_D}	Enable delay	Programmable in 800 μs steps	0		2.4	ms
t_{DIS_D}	Disable delay	Programmable	0		10	ms

Parameter	Description	Conditions	Min	Typ	Max	Unit
R_{PD_FB}	Feedback pull-down resistor	$V_{OUT} = 0.5\text{ V}$ Disabled by OTP		30		Ω
η_{100}	Efficiency	$V_{IN4} = 5.0\text{ V}$ $V_{OUT} = 1.2\text{ V}$ $I_{OUT} = 1\text{ mA to }100\text{ mA}$ Note 1		85		%
η_{1000}	Efficiency	$V_{IN4} = 5.0\text{ V}$ $V_{OUT} = 1.2\text{ V}$ $I_{OUT} = 100\text{ mA to }1\text{ A}$		85		%
η_{2000}	Efficiency	$V_{IN4} = 5.0\text{ V}$ $V_{OUT} = 1.2\text{ V}$ $I_{OUT} = 1\text{ A to }2\text{ A}$		80		%
η_{2500}	Efficiency	$V_{IN4} = 5.0\text{ V}$ $V_{OUT} = 1.2\text{ V}$ $I_{OUT} = 2\text{ A to }2.5\text{ A}$		75		%

Note 1 VIN4 current only

4.3.7 CH5 Voltage Regulator Characteristics

Unless otherwise noted, the following is valid for $-40\text{ }^{\circ}\text{C} \leq T_A \leq +85\text{ }^{\circ}\text{C}$, $1.176\text{ V} \leq V_{IN5} \leq 1.377\text{ V}$.

Table 11. CH5 Voltage Regulator Characteristics

Parameter	Description	Conditions	Min	Typ	Max	Unit
External electrical conditions						
V_{IN5}	Input voltage	CH4 output	1.176	1.2	1.224	V
			1.323	1.35	1.377	
C_{OUT}	Output Capacitor	Including voltage and temperature coefficient	5	10	12	μF
ESR_{COUT}	ESR of C_{OUT}	$f > 1\text{ MHz}$ including track impedance			10	m Ω
Electrical performance						
V_{OUT}	Output voltage	$V_{OUT4} = 1.2\text{ V}$ or 1.35 V		$V_{out4}/2$		V
V_{OUT_ACC}	Overall output accuracy		-2		2	%
I_{OUT_SINK}	Maximum sink current		500			mA
I_{OUT_SRC}	Maximum source current				-500	mA
I_{LIM_SINK}	Sink current limit			700		mA
I_{LIM_SRC}	Source current limit			-700		mA
$V_{OUT_TR_LD}$	Transient load regulation	$I_{OUT} = -300\text{ mA}$ to 300 mA $dI/dt = 0.1\text{ A}/\mu\text{s}$ Including DC accuracy	-5		5	%
t_{EN_D}	Enable delay	Note 1	0	100		μs
$t_{SOFTSTART}$	Soft-start time	Programmable in $200\text{ }\mu\text{s}$ steps	0.4		0.8	ms
$t_{SOFTSTART_ACC}$	Soft-start time accuracy		-0.1		0.1	ms
R_{PD}	Pull-down resistance in OFF mode	$V_{OUT} = 0.5\text{ V}$ Disable by OTP		100		Ω

Note 1 CH5 start-up triggered by CH4 soft-start completion.

4.3.8 CH6 LDO Characteristics

Unless otherwise noted, the following is valid for $-40\text{ }^{\circ}\text{C} \leq T_A \leq +85\text{ }^{\circ}\text{C}$, $4.5\text{ V} \leq V_{IN6} \leq 5.5\text{ V}$.

Table 12. CH6 LDO Characteristics

Parameter	Description	Conditions	Min	Typ	Max	Unit
External electrical conditions						
V_{IN6}	Input voltage	Power stage supplied	4.5	5	5.5	V
C_{OUT}	Output Capacitor	Including voltage and temperature coefficient	2.35	4.7	5.64	μF
ESR_{COUT}	ESR of C_{OUT}	$f > 1\text{ MHz}$ including track impedance			10	$\text{m}\Omega$
Electrical performance						
V_{OUT}	Output voltage at lowest V_{OUT} setting			2.5		V
V_{OUT_ACC}	Overall output accuracy	Including load and line regulation	-2		2	%
I_{OUT_MAX}	Maximum output current		200			mA
I_{LIM}	Current limit			350		mA
$V_{OUT_TR_LD}$	Transient load regulation	10 mA to 150 mA $di/dt = 0.05\text{ A}/\mu\text{s}$ Including DC accuracy	-5		5	%
t_{EN_D}	Enable delay	Programmable in 800 μs steps	0		2.4	ms
$t_{SOFTSTART}$	Soft-start time	Programmable in 200 μs steps	0.4		0.8	ms
$t_{SOFTSTART_ACC}$	Soft-start time accuracy		-0.1		0.1	ms
t_{DIS_D}	Disable delay	Programmable	0		10	ms
R_{PD}	Pull-down resistance in OFF mode	$V_{OUT} = 0.5\text{ V}$ Disable by OTP		400		Ω

4.3.9 CH7 LDO Characteristics

Unless otherwise noted, the following is valid for $-40\text{ }^{\circ}\text{C} \leq T_A \leq +85\text{ }^{\circ}\text{C}$, $4.5\text{ V} \leq V_{IN7} \leq 5.5\text{ V}$.

Table 13. CH7 LDO Characteristics

Parameter	Description	Conditions	Min	Typ	Max	Unit
External electrical conditions						
V_{IN7}	Input voltage		4.5	5	5.5	V
C_{OUT}	Output Capacitor	Including voltage and temperature coefficient	2.35	4.7	5.64	μF
ESR_{COUT}	ESR of C_{OUT}	$f > 1\text{ MHz}$ including track impedance			10	$\text{m}\Omega$
Electrical performance						
V_{OUT_SEL0}	Output voltage	$CH7_VOUT = 0x0$		1.8		V
V_{OUT_SEL1}	Output voltage	$CH7_VOUT = 0x1$		3.3		V
V_{OUT_ACC}	Overall output accuracy	Including load and line regulation	-2		2	%
I_{OUT_MAX}	Maximum output current		200			mA
I_{LIM}	Current limit			350		mA
$V_{OUT_TR_LD}$	Transient load regulation	$V_{OUT} = 1.8\text{ V}, 3.3\text{ V}$ 10 mA to 150 mA $dl/dt = 0.05\text{ A}/\mu\text{s}$ Including DC accuracy	-5		5	%
t_{EN_D}	Enable delay	Programmable in 800 μs steps	0		2.4	ms
$t_{SOFTSTART}$	Soft-start time	Programmable in 200 μs steps	0.4		0.8	ms
$t_{SOFTSTART_ACC}$	Soft-start time accuracy		-0.1		0.1	ms
t_{DIS_D}	Disable delay	Programmable	0		10	ms
R_{PD}	Pull-down resistance in OFF mode	$V_{OUT} = 0.5\text{ V}$ Disable by OTP		400		Ω

4.3.10 CH8 LDO Characteristics

Unless otherwise noted, the following is valid for $-40\text{ }^{\circ}\text{C} \leq T_A \leq +85\text{ }^{\circ}\text{C}$, $1.98\text{ V} \leq V_{IN8} \leq 2.12\text{ V}$.

Table 14. CH8 LDO Characteristics

Parameter	Description	Conditions	Min	Typ	Max	Unit
External electrical conditions						
V_{IN8}	Input voltage		1.98	2	2.12	V
C_{OUT}	Output Capacitor	Including voltage and temperature coefficient	11	22	26.4	μF
ESR_{COUT}	ESR of C_{OUT}	$f > 1\text{ MHz}$ including track impedance			10	$\text{m}\Omega$
Electrical performance						
V_{OUT}	Output voltage			1.8		V
V_{OUT_ACC}	Overall output accuracy	Including load and line regulation	-2		2	%
I_{OUT_MAX}	Maximum output current		1.6			A
I_{LIM}	Current limit			2.5		A
$V_{OUT_TR_LD}$	Transient load regulation	0.1 A to 1.46 A $dI/dt = 0.5\text{ A}/\mu\text{s}$ Including DC accuracy	-5		5	%
$V_{DROPOUT}$	Dropout voltage Note 1	$V_{OUT} = V_{OUT_SET} - 10\text{ mV}$ $I_{OUT} = I_{OUT_MAX}$			180	mV
t_{EN_D}	Enable delay	Programmable in 800 μs steps	0		2.4	ms
$t_{SOFTSTART}$	Soft-start time	Programmable in 200 μs steps	0.4		0.8	ms
$t_{SOFTSTART_ACC}$	Soft-start time accuracy		-0.1		0.1	ms
t_{DIS_D}	Disable delay	Programmable	0		10	ms
R_{PD}	Pull-down resistance in OFF mode	$V_{OUT} = 0.5\text{ V}$ Disable by OTP		50		Ω

Note 1 Difference between input and output of the LDO should exceed this parameter.

4.3.11 Digital I/O Characteristics

Table 15. Digital I/O Electrical Characteristics

Parameter	Description	Conditions	Min	Typ	Max	Unit
External Electrical Conditions						
V_{IH_SDA}	Input high voltage SDA	Note 1	1.26			V
V_{IL_SDA}	Input low voltage SDA	Note 1			0.54	V
V_{OL_SDA}	Output low voltage SDA	Open drain IOUT_SDA = 3 mA			0.36	V
V_{IH_SCL}	Input high voltage SCL	Note 1	1.26			V
V_{IL_SCL}	Input low voltage SCL	Note 1			0.54	V
V_{IH_EN}	Input high voltage EN	Note 2	1.26			V
V_{IL_EN}	Input low voltage EN				0.54	V

Note 1 Input range compatible with 1.8 V and 3.3 V logic.

Note 2 The applied voltage on the EN pin shall not exceed V_{INX} limits.

4.4 Timing Characteristics

Table 16. I²C Characteristics

Parameter	Description	Conditions	Min	Typ	Max	Unit
Electrical performance						
t _{BUS}	Bus free time between a STOP and START condition		1.3			μs
C _{BUS}	Bus line capacitive load				400	pF
f _{SCL}	SCL clock frequency				400	kHz
t _{LO_SCL}	SCL low time		0.6			μs
t _{HI_SCL}	SCL high time		0.6			μs
t _{RISE}	SCL and SDA rise time. Requirement for input.				300	ns
t _{FALL}	SCL and SDA fall time. Requirement for input.				300	ns
t _{SETUP_START}	Start condition setup time		0.6			μs
t _{HOLD_START}	Start condition hold time		0.6			μs
t _{SETUP_STOP}	Stop condition setup time		0.6			μs
t _{SETUP_DATA}	Data setup time		100			ns
t _{HOLD_DATA}	Data hold time		0			ns
t _{SPIKE}	Spike suppression pulse width		0		50	ns

5. Typical Performance Graphs

This section contains some typical performance data for the DA9281 device. Unless otherwise noted, the operating conditions are:

$T_A = 25\text{ }^{\circ}\text{C}$, $V_{IN} = 5\text{ V}$, $f_{sw} = 2\text{ MHz}$, $L_1 = 470\text{ nH}$, $L_{2,3,4} = 1\text{ }\mu\text{H}$, $C_{OUT_1} = 5 \times 22\text{ }\mu\text{F}$, $C_{OUT_2,3,4} = 3 \times 22\text{ }\mu\text{F}$ and Mode = AUTO.

Note 1 AUTO mode = Automatic transitions between PWM mode and PFM.

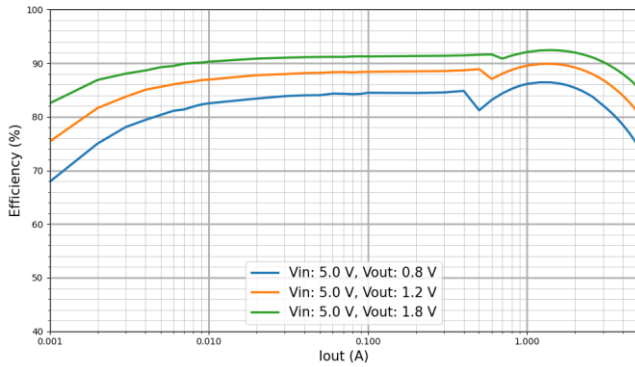


Figure 4. CH1 Buck Efficiency

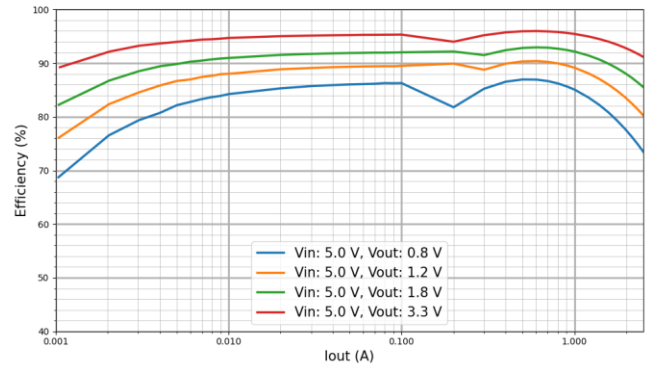


Figure 5. CH2 Buck Efficiency

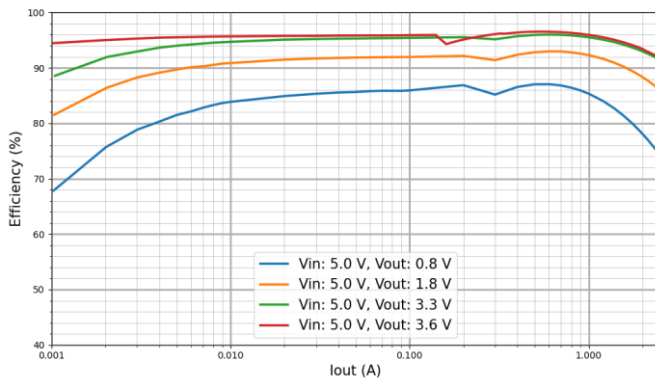


Figure 6. CH3 Buck Efficiency

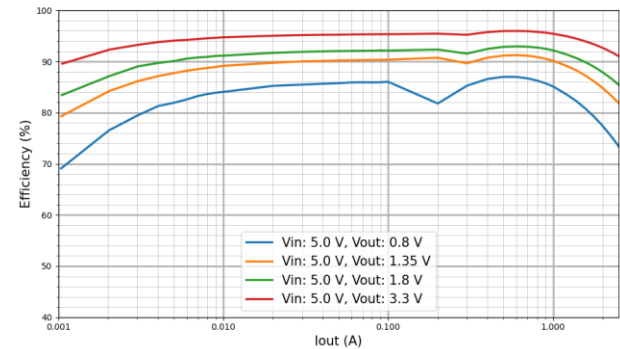


Figure 7. CH4 Buck Efficiency

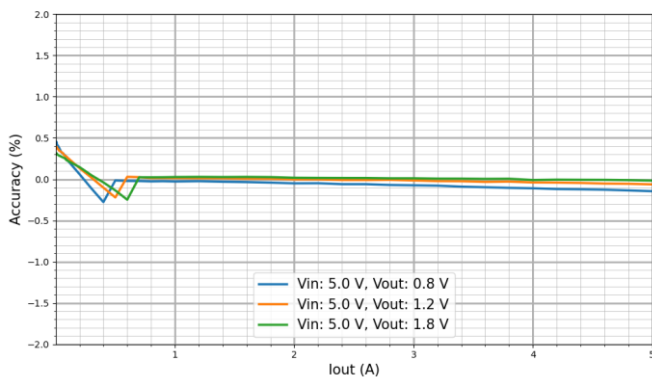


Figure 8. CH1 Buck Load Regulation

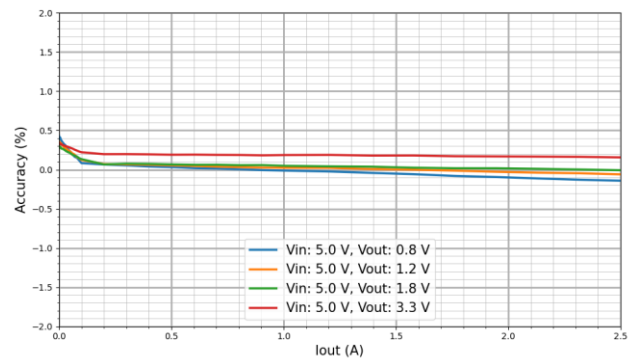


Figure 9. CH2 Buck Load Regulation

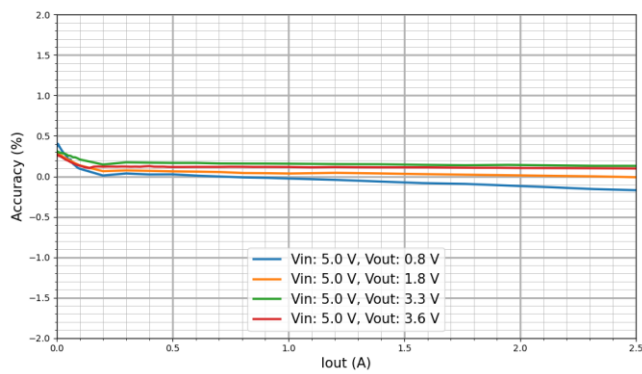


Figure 10. CH3 Buck Load Regulation

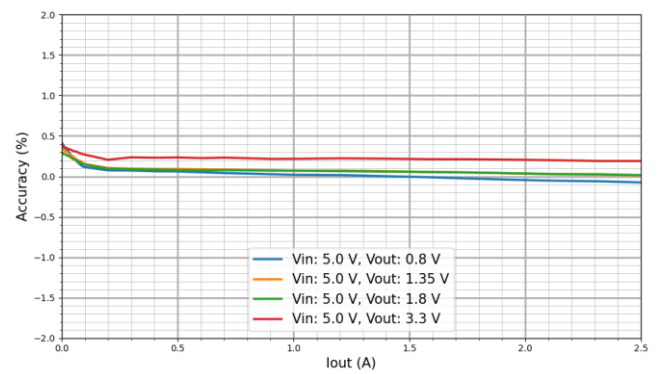


Figure 11. CH4 Buck Load Regulation

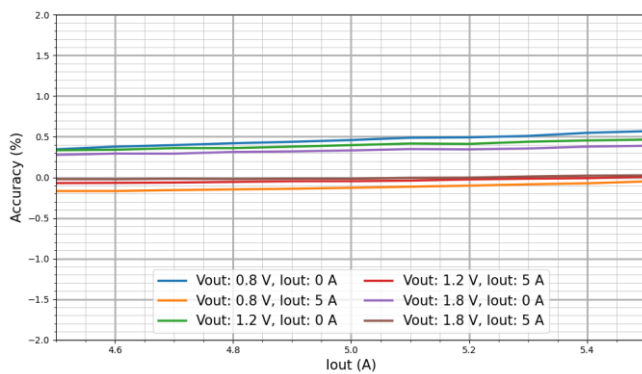


Figure 12. CH1 Buck Line Regulation

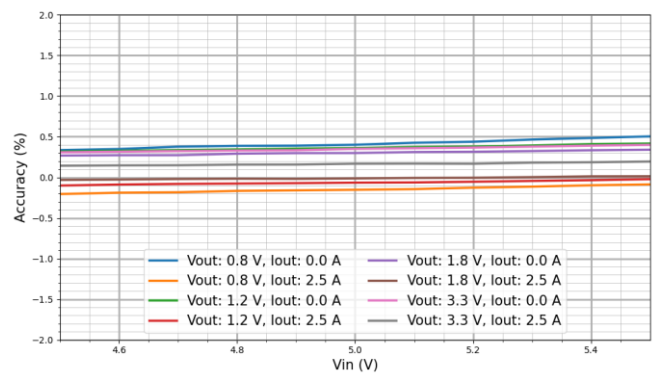


Figure 13. CH2 Buck Line Regulation

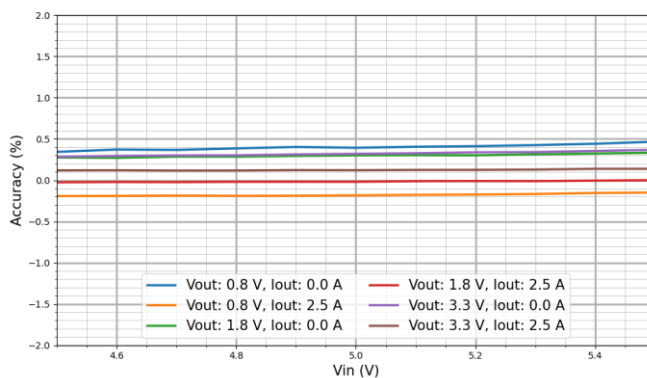


Figure 14. CH3 Buck Line Regulation

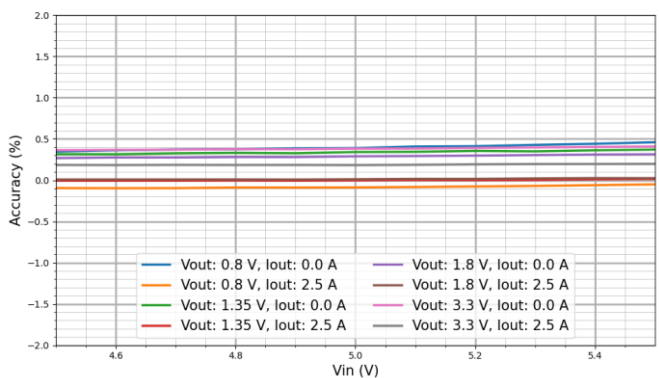


Figure 15. CH4 Buck Line Regulation

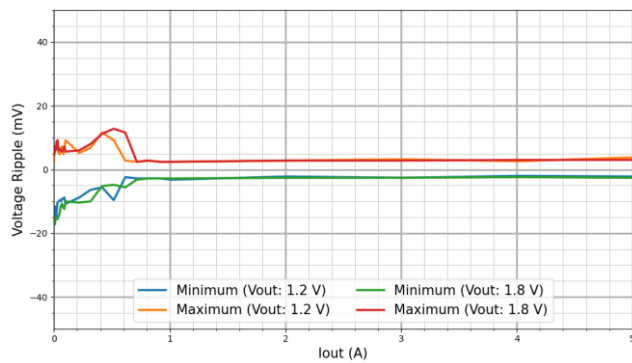


Figure 16. CH1 Buck Minimum and Maximum Ripple

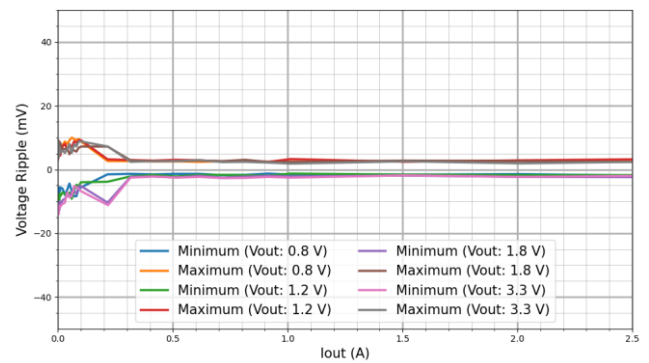


Figure 17. CH2 Buck Minimum and Maximum Ripple

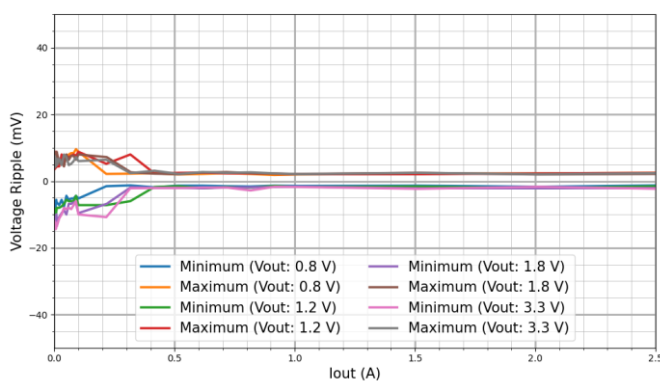


Figure 18. CH3 Buck Minimum and Maximum Ripple

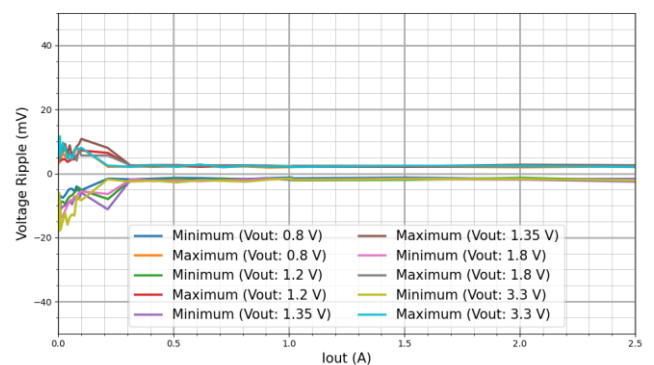


Figure 19. CH4 Buck Minimum and Maximum Ripple

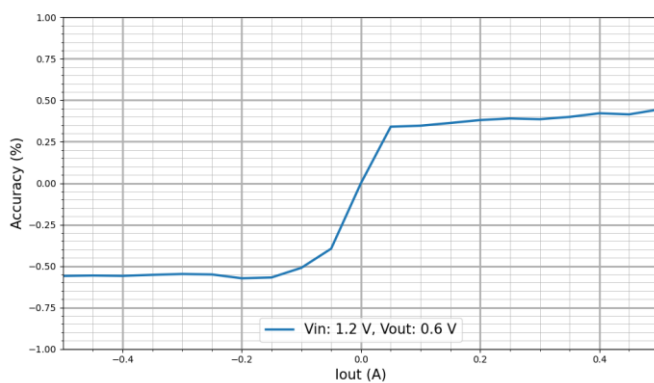
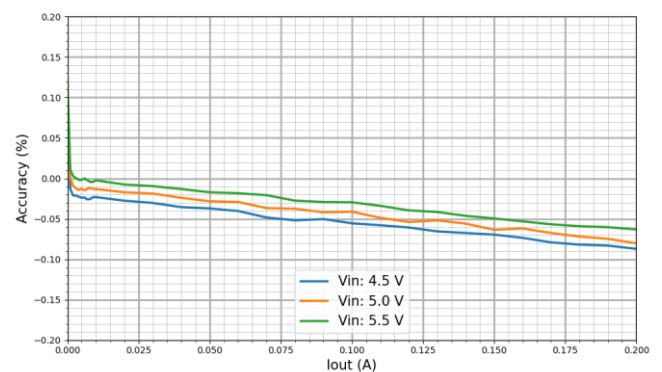


Figure 20. CH5 Voltage Regulator Load Regulation

Figure 21. CH6 LDO Line Regulation ($V_{OUT} = 2.5\text{ V}$)

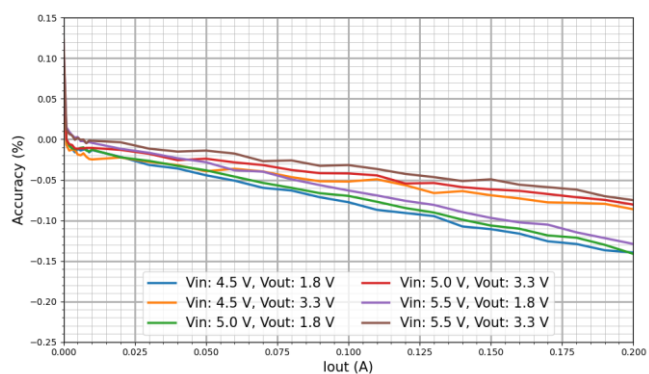


Figure 22. CH7 LDO Line Regulation (VOUT = 1.8 V, 3.3 V)

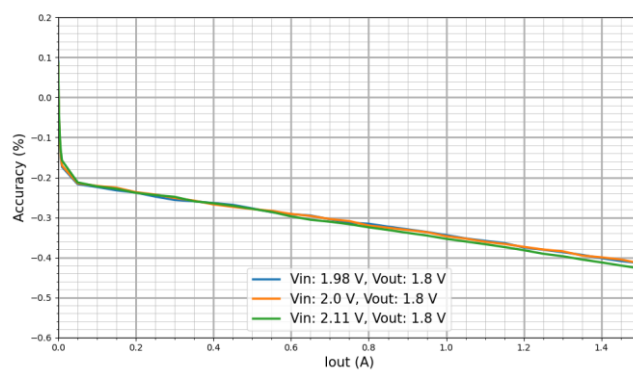


Figure 23. CH8 LDO Line Regulation (VOUT = 1.8 V)

6. Functional Description

DA9281 is an 8-channel PMIC optimized for supplying system, I/O, and peripheral rails.

DA9281 features four buck regulators. High efficiency is achieved over a wide load range by implementing auto mode. All switches are fully integrated so that external Schottky Diodes are not required. There are also three LDO regulators. In addition, there is a termination voltage regulator (VTT). All eight channels have an output discharge function and protection features such as OCP, UVP and OVP.

DA9281 features a programmable power sequencer that handles start-up and shutdown sequences.

These functions are programmed using the I²C interface.

6.1 POWER_OFF, SHUTDOWN, OPERATING, UVLO, and Thermal Shutdown State Transitions

6.1.1 State Diagram

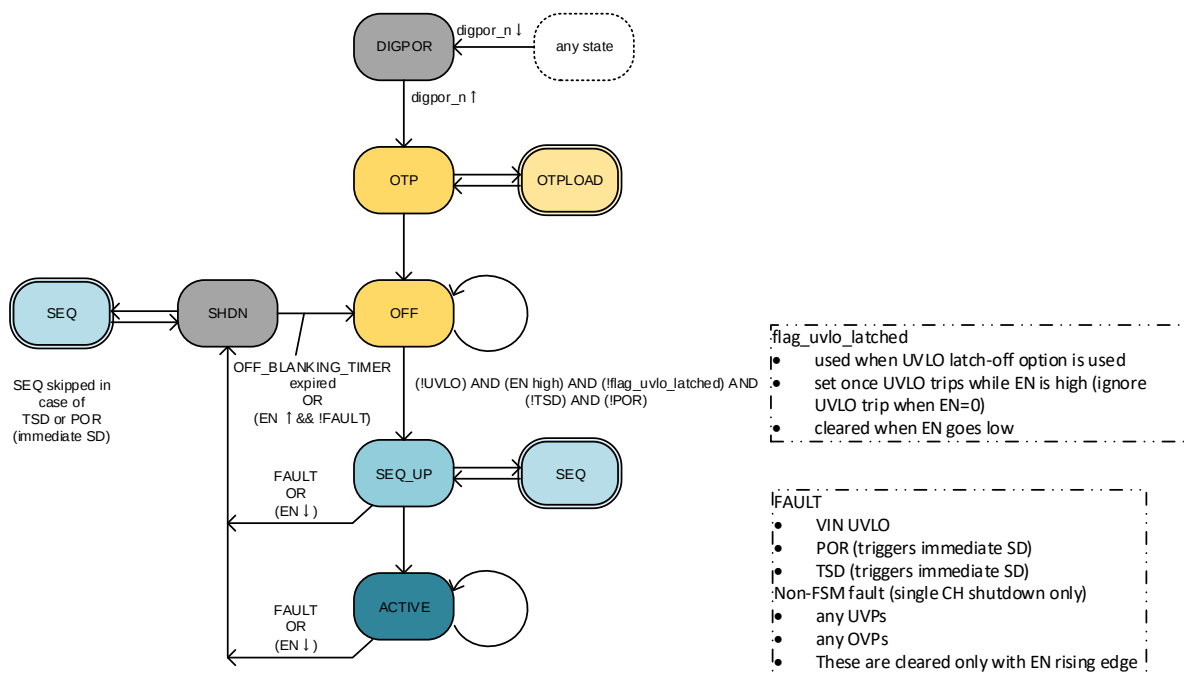


Figure 24. State Transitions Diagram

6.1.2 Mode Description

- **DIGPOR:** The digital circuit is in POR. Once DIGPOR is released, the FSM automatically transitions to the OTP load state.
- **OTP:** In the OTP state the OTP load is handled by the sub-FSM for OTP load. All OTP programmable registers are configured with the data from OTP in this phase. Once all registers have been configured, the FSM moves to OFF.
- **OFF:** In the OFF state the device waits for all conditions to allow enabling the channels. The VIN must not be in a UV condition (UVLO or POR) and the UVLO stored flag must not be set (in case the latch-off option is used), the junction temperature must be below the temperature shutdown threshold minus the hysteresis and in addition the EN pin needs to be high.
- **SEQ_UP:** In this state the channels are being enabled according to their delay configurations by the SEQ sub-FSM. The channels also run through their soft-start before exiting this state towards ACTIVE. This state is left immediately towards SHDN in case of a fault (VIN UVLO, POR, TSD) or if the EN pin is set low.
- **ACTIVE:** All channels are enabled. This state is left towards SHDN in case of a fault (UVLO, POR, TSD) or if the EN pin is set low.
- **SHDN:** In SHDN the SEQ sub-FSM takes care of disabling the channels according to their configured timing. In case of TSD or POR the channel shutdown happens immediately. After shutting down the channels a

10 ms wait time (OFF_BLANKING_TIMER) needs to pass before going back to OFF. This is done to allow the channels to be adequately discharged. This wait time can be skipped or shortened, if the transition to OFF was triggered by the EN pin going low, no-fault conditions present in the shutdown and the EN pin goes high again.

6.2 Startup and Shutdown Sequences

6.2.1 CH1, CH2, CH3, CH4 Soft Start-Up

To limit in-rush current from V_{INx} , the buck converters (CH1 to CH4) perform a soft start-up after being enabled.

The soft start-up slew rates are selectable as shown below in [CH<x>_SS](#):

Table 17. CH<x> Slew Rates

CH<x>_SS	CH1 Slew Rate	CH2 Slew Rate	CH3 Slew Rate	CH4 Slew Rate
0.4 ms	10 mV / 5 μ s	10 mV / 3.25 μ s		
0.6 ms	10 mV / 7.5 μ s	10 mV / 5 μ s		
0.8 ms	10 mV / 10 μ s	10 mV / 6.75 μ s		

6.2.2 Normal Startup Sequence

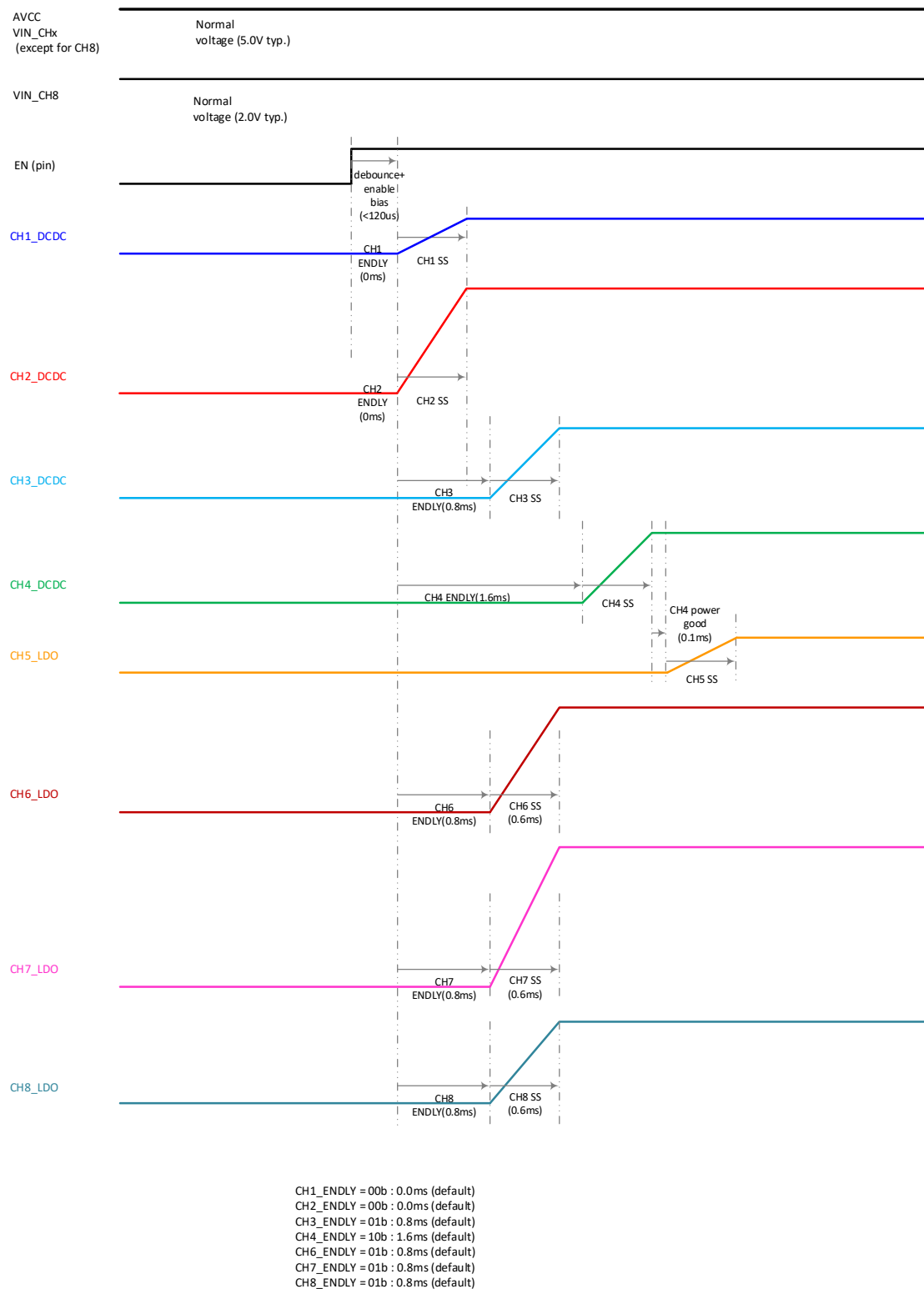


Figure 25. Normal Startup Sequence

6.2.3 Normal Shutdown Sequence

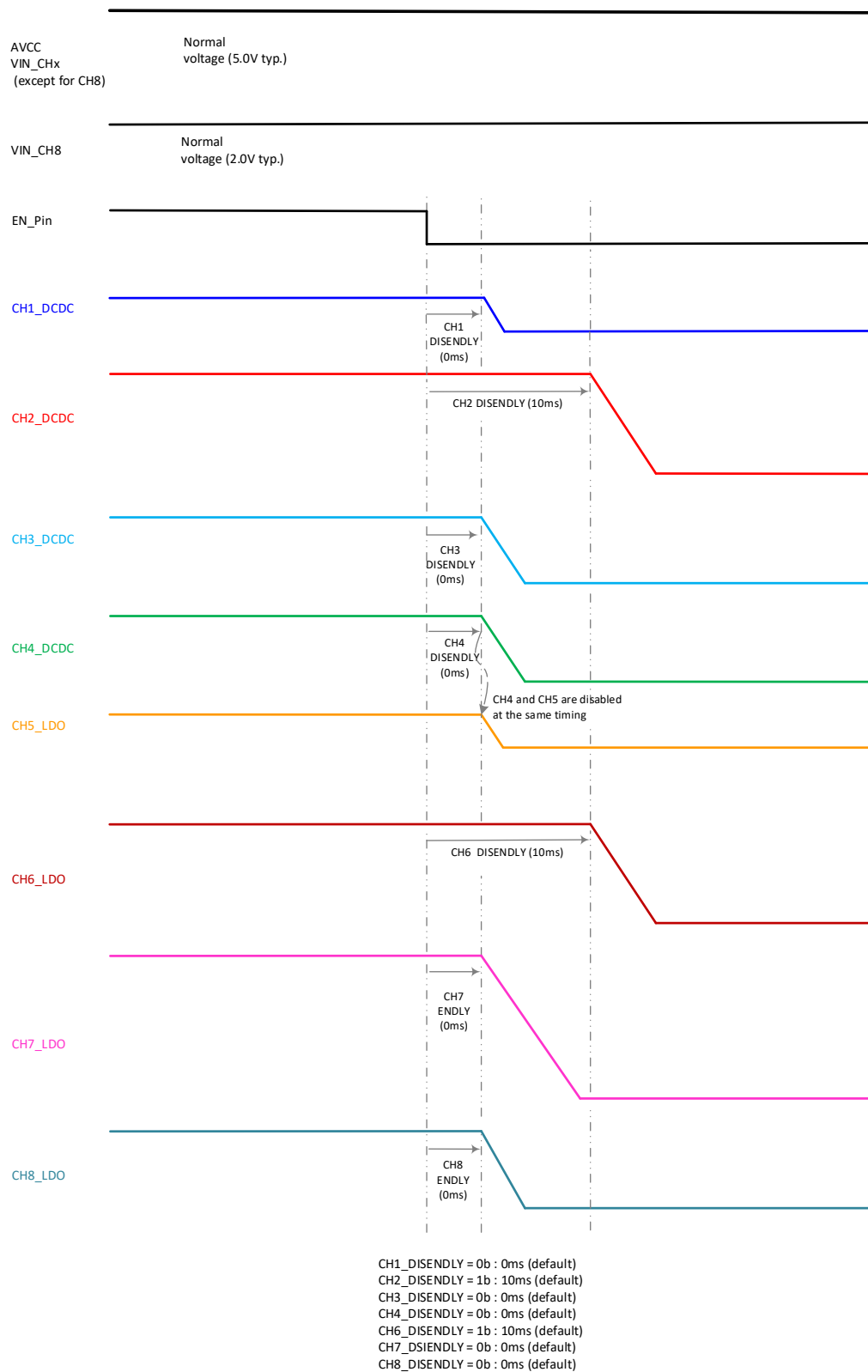


Figure 26. Normal Shutdown Sequence

6.2.4 UVLO Falling Shutdown

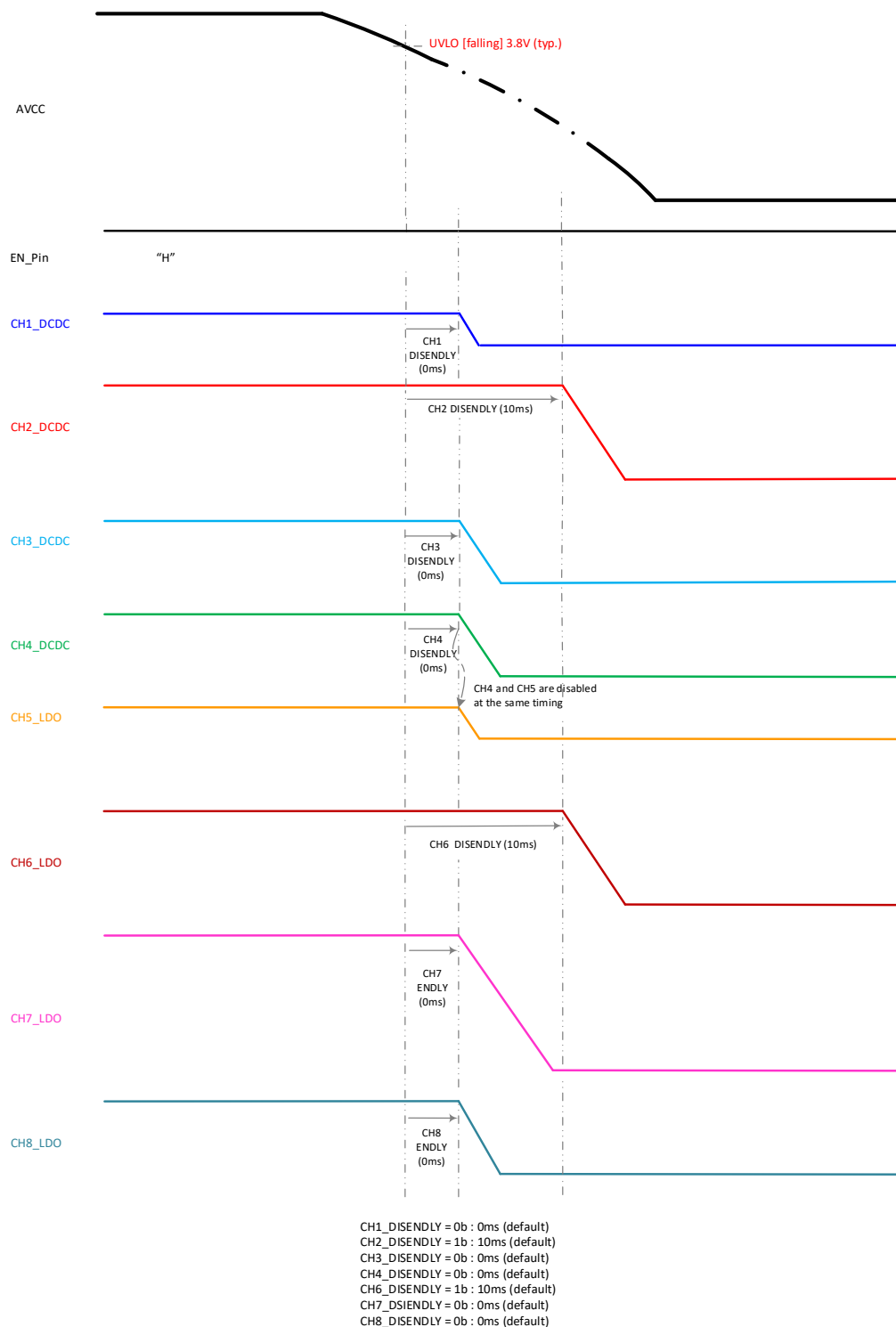


Figure 27. UVLO Falling Shutdown Sequence 1

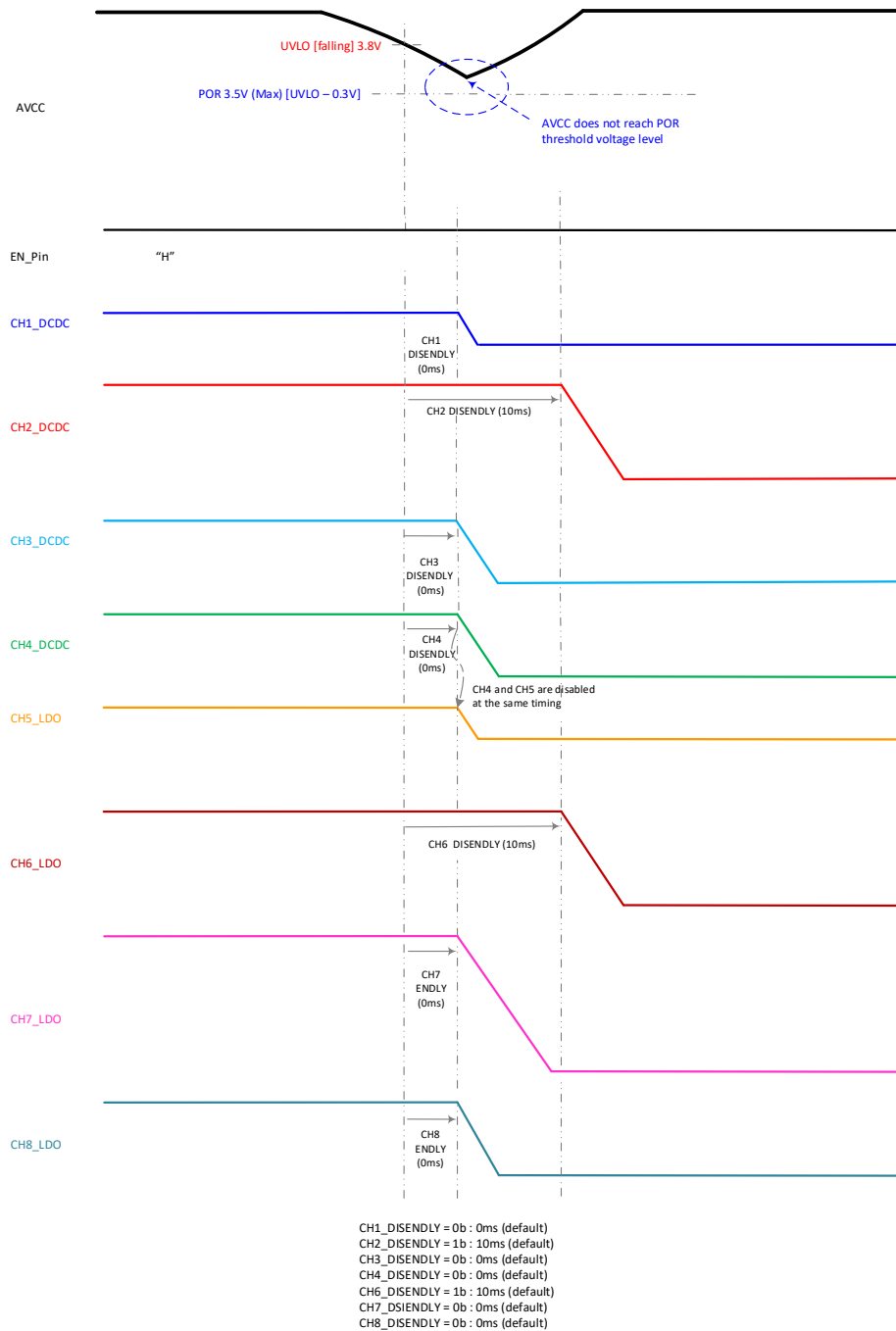


Figure 28. UVLO Falling Shutdown Sequence 2

6.2.5 POR Falling Shutdown

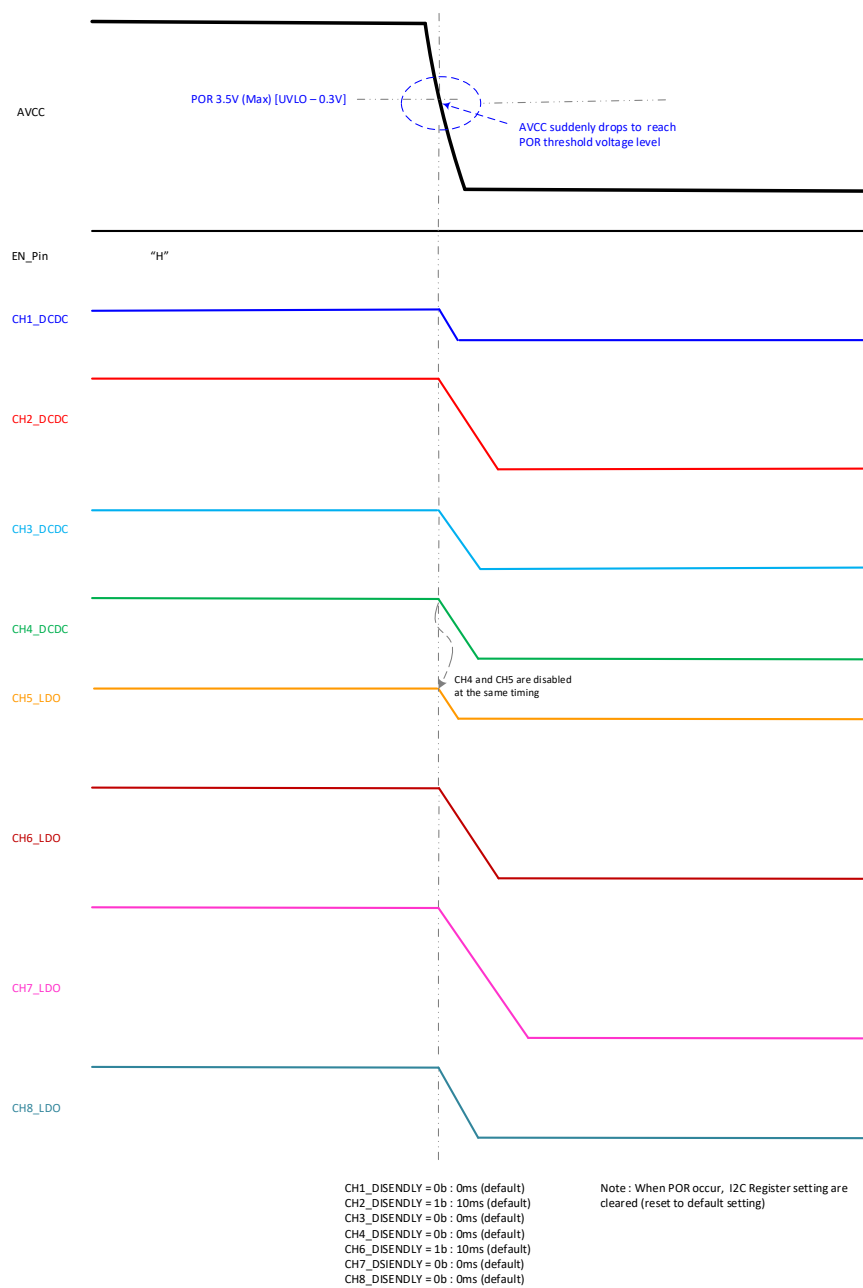


Figure 29. POR Falling Shutdown

6.2.6 TSD Thermal Shutdown Sequence

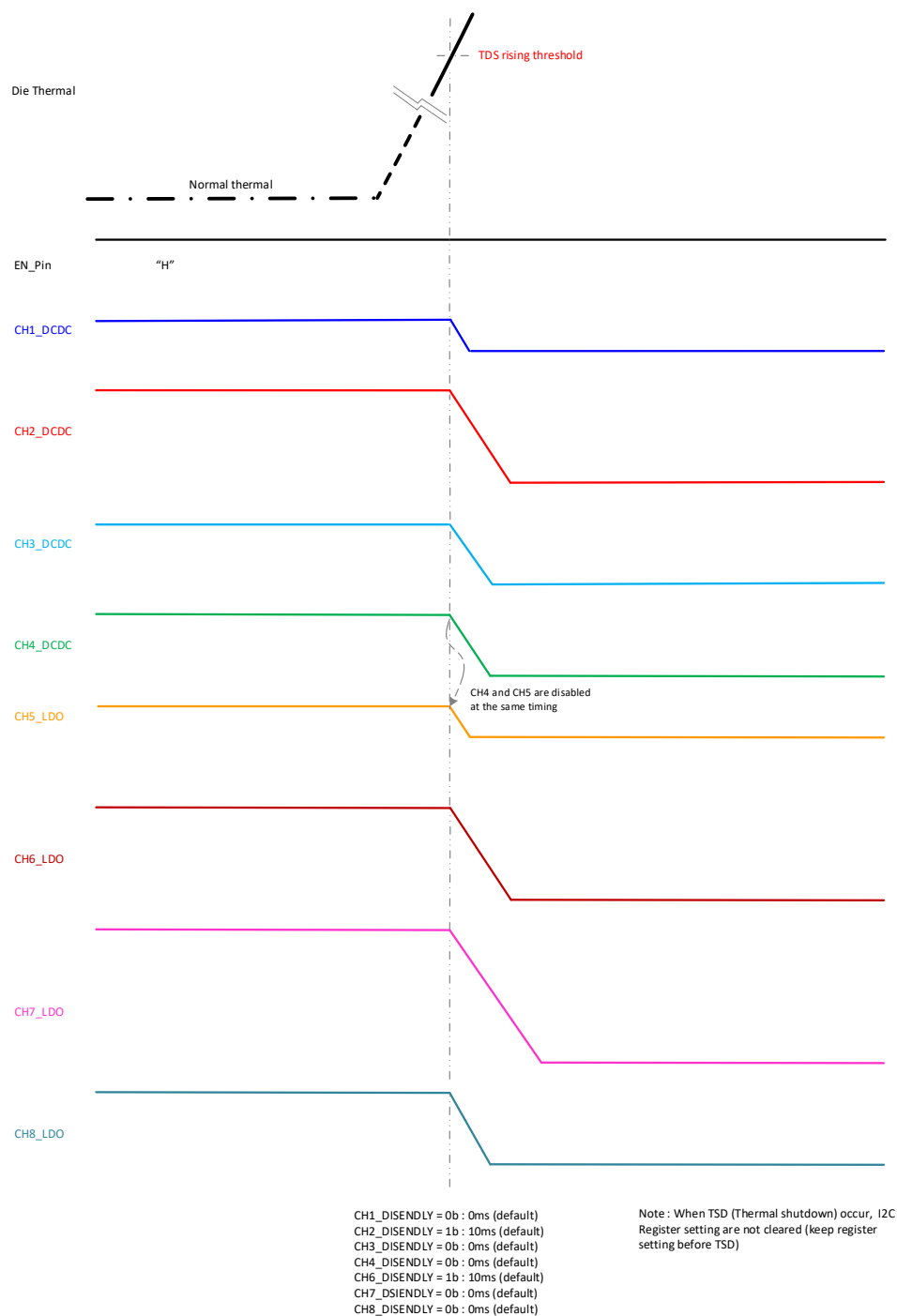


Figure 30. TSD Shutdown

6.2.7 Restart Sequence POR Released

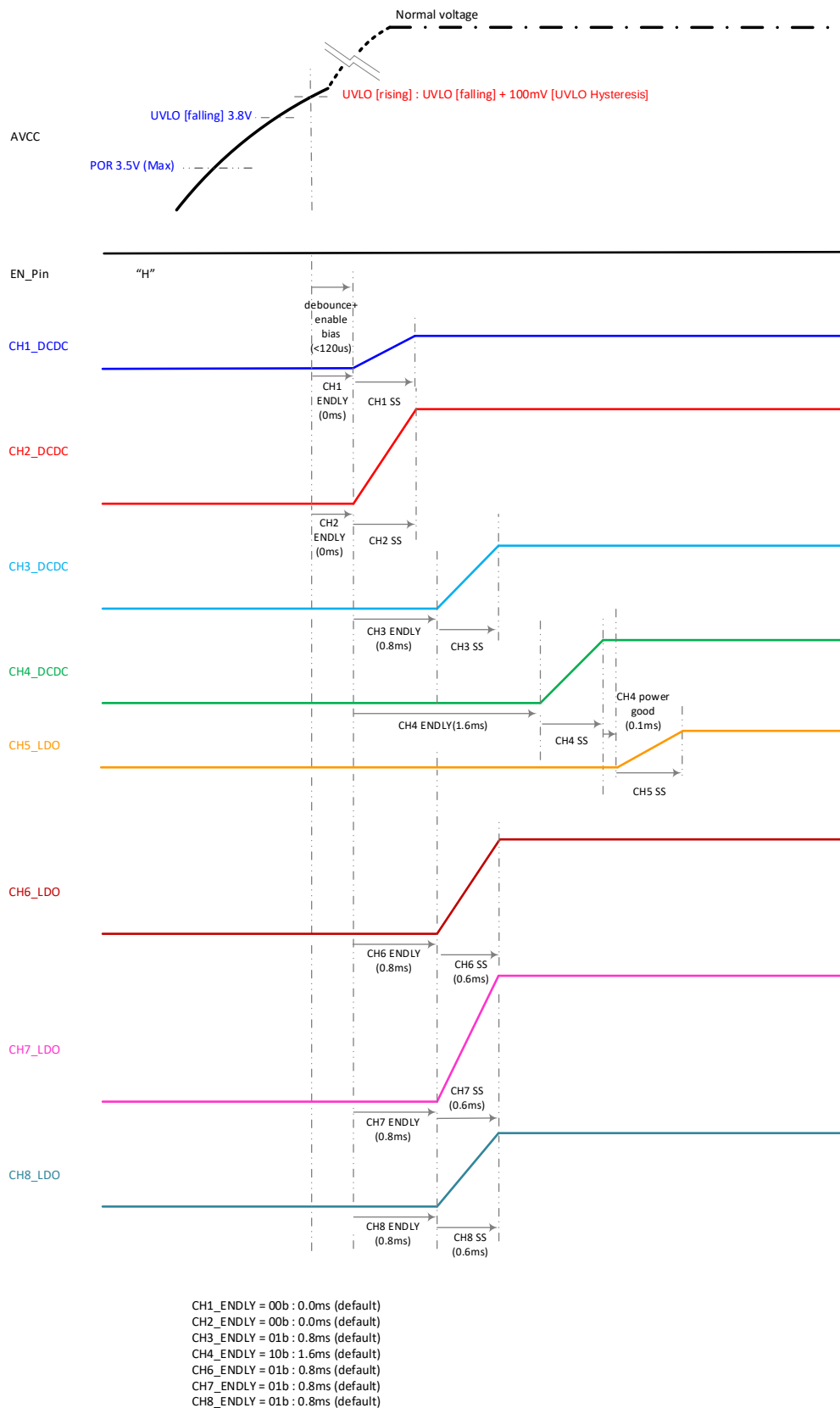


Figure 31. Restart Sequence after POR Released

6.2.8 Restart Sequence TSD Released

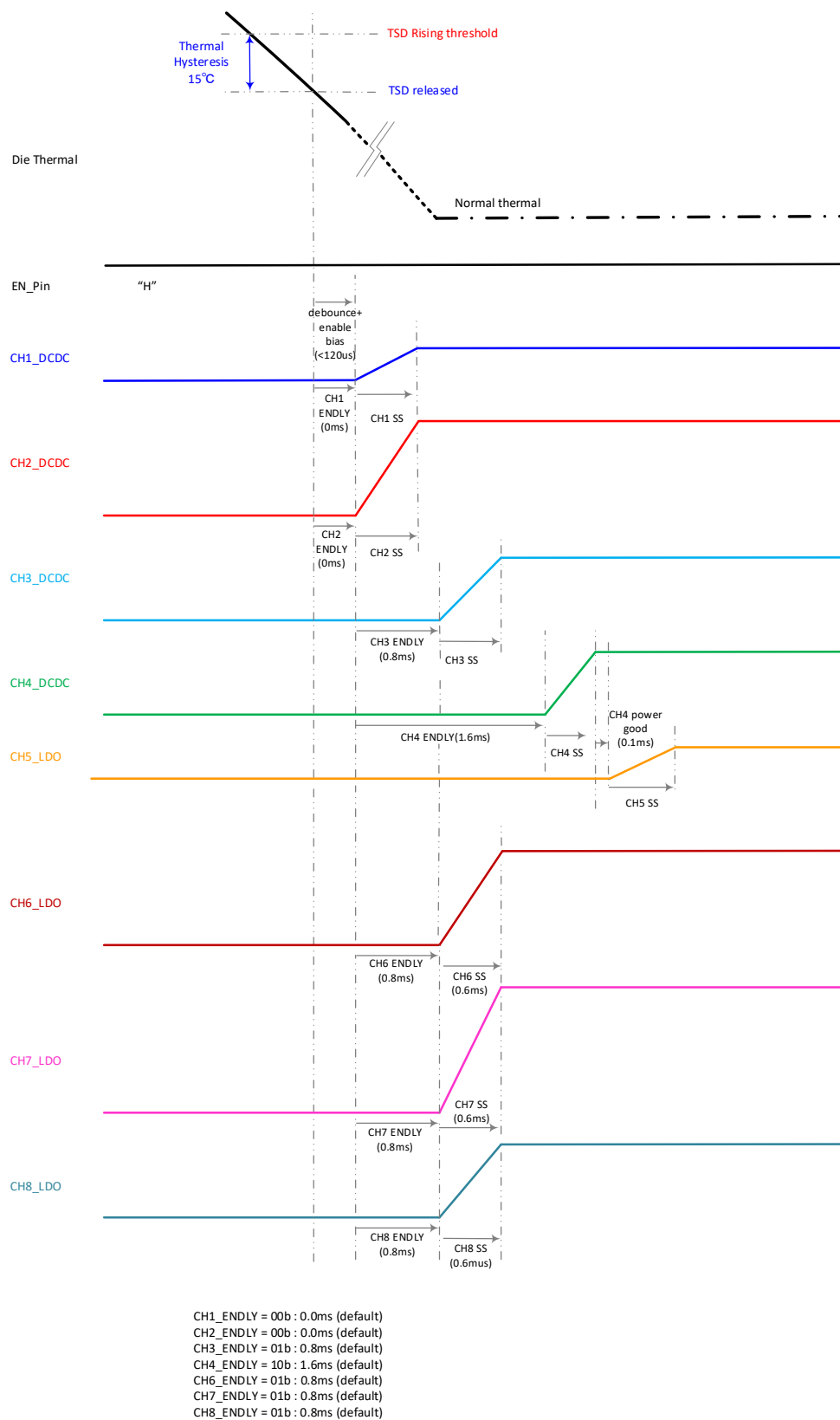


Figure 32. Restart Sequence after TSD Released

6.3 Supervisory and Protection Functions

6.3.1 Under-Voltage Lockout

DA9281 has an under-voltage lockout (UVLO) function circuit to monitor the input voltage state at the AVCC power supply and control internal circuit operation.

Whilst operating, the supply voltage at AVCC decreases and when it falls below UVLO detection voltage falling threshold (3.8 V typ. as default), all channels (buck regulators (CH1-CH4), LDOs (CH6, CH7, and CH8) and VTT regulator (CH5)) are sequentially disabled and then the output capacitors are discharged using pull-down resistances, in order to prevent malfunction.

The following behavior when AVCC increases after UVLO is programmable (UVLO latch-off turned “off” or “on” is set by OTP). The current sample device is set to UVLO latch-off turned “on”. For details, please consult your Renesas [local sales representative](#).

- With UVLO latch-off turned “off”: When the power supply voltage at AVCC increases and exceeds the UVLO release voltage including hysteresis (100 mV typ.), UVLO is released, and then all channels restart automatically.
- With UVLO latch-off turned “on”: The chip cannot restart directly, but the enable pin EN needs to be pulled “low” first to clear the UVLO flag. Only then, with EN “high”, the chip will power up the channels again.

6.3.2 Thermal Shutdown

DA9281 has a Thermal Shutdown (TSD) function circuit to monitor the terminal temperature on the device and to control internal circuit operation.

Whilst operating, the terminal temperature increases and when it exceeds thermal rising threshold (140 °C typ.) all channels (buck regulators (CH1-CH4), LDOs (CH6, CH7, and CH8) and VTT regulator (CH5)) are disabled immediately and then the output capacitors are discharged using pull down resistances, in order to prevent malfunction.

When the terminal temperature decreases and becomes lower than thermal hysteresis (15 °C typ.), TSD is released, and then all channels restart.

6.3.3 Over-Current Protection

All channels (from CH1 to CH8) on DA9281 have an OCP function circuit to monitor over-current.

This function automatically limits the output current when it exceeds the regulated (current limit) value.

If it returns to the regulated (current limit) value or less than current limit value, it automatically returns to normal operation.

Although the shutdown operation is not executed by this function, if the current is exceeding the regulated (current limit) value, the output voltage will fall with the function (over-current limitation). As a result, UVP may be detected and the output is shut down.

6.3.4 Under-Voltage Protection

All channels (from CH1 to CH8) on DA9281 have an UVP function circuit to monitor under-voltage.

Channels CH1 to CH8 output is shut down after detecting voltage lower than the reference voltage (70 % typ.) for the regulation period time (100 µs typ.)

To restart the channel after UVP, the EN pin must be first set to “low”. The channels can power up again from the rising edge of the EN pin.

6.3.5 Over-Voltage Protection

Channels CH1 to CH8 on DA9281 have an OVP function circuit to monitor over-voltage.

Channels CH1 to CH8 output is shut down after detecting voltage higher than the reference voltage (120 % typ.) for the regulation period time (100 µs typ.).

To restart the channel after OVP, the EN pin must be first set to “low”. The channels can power up again from the rising edge of the EN pin.

6.3.6 DC-DC Latch Off Protection

Figure 33 shows the function operation of latch off protection on CH1-CH4 DC-DC converter which are enabled by the EN pin, the example shown is CH1 DC-DC.

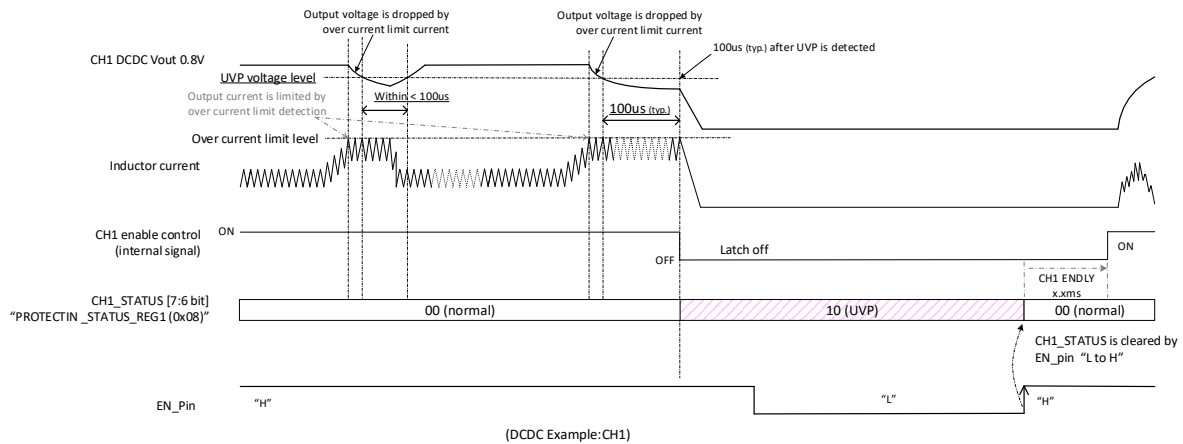


Figure 33. DC-DC Shutdown due to OCP/UVP

6.3.7 LDO Latch Off Protection

Figure 34 shows the function operation of latch off protection on CH5 and CH6 LDOs, which are enabled by the EN pin, the example shown is CH6 LDO.

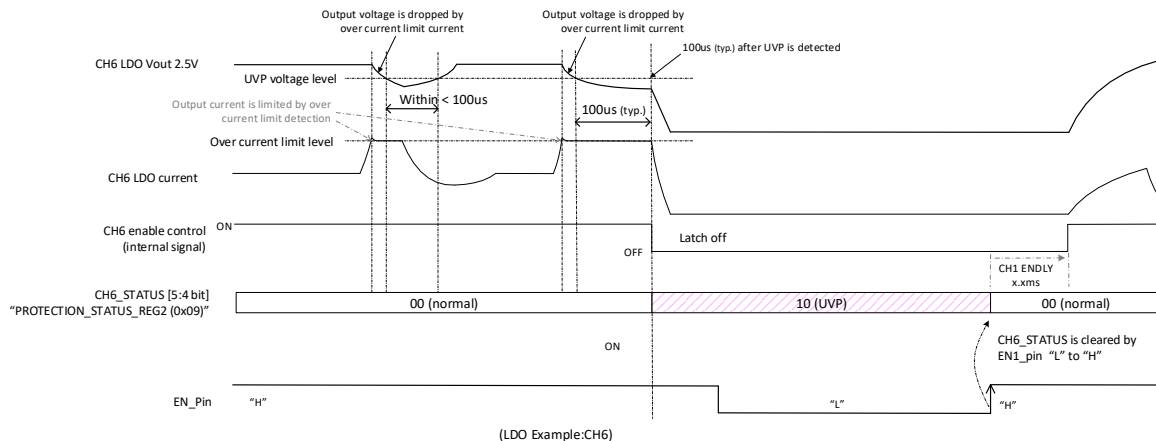


Figure 34. LDO Shutdown due to OCP/UVP

6.3.8 UVP Behavior during Soft-Start

During Soft-Start of all channels CH1-CH8, the UVP are masked so that no incorrect UVP flags are generated. The masking ends 100 µs after the end of the Soft-Start period. If the channel did not start up correctly, the UVP flag is raised 200 µs after the end of Soft-Start since this includes the 100 µs delay for the UVP masking release plus 100 µs minimum observe time before the flag is raised.

An example is shown in Figure 35.

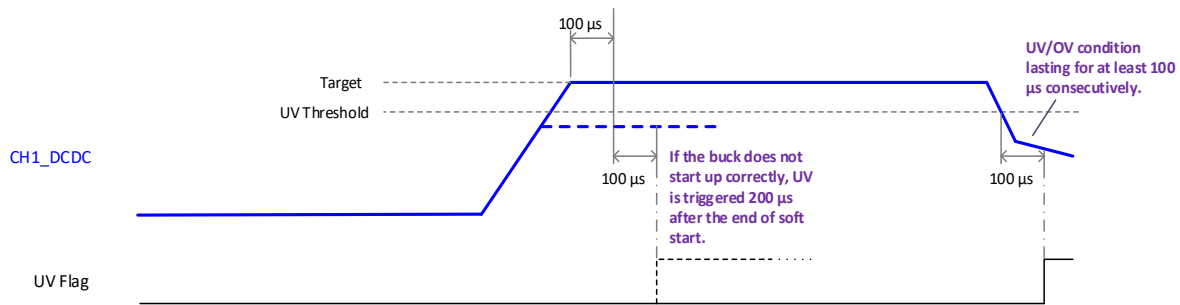


Figure 35. UVP Behavior during Soft-Start

6.4 I²C Communication

DA9281 includes an I²C-compatible 2-wire serial interface to access the internal registers. Using the I²C interface, the host processor can control each channel and read back the system status. only operates as a slave device. For detailed information about each register, see Section 7.

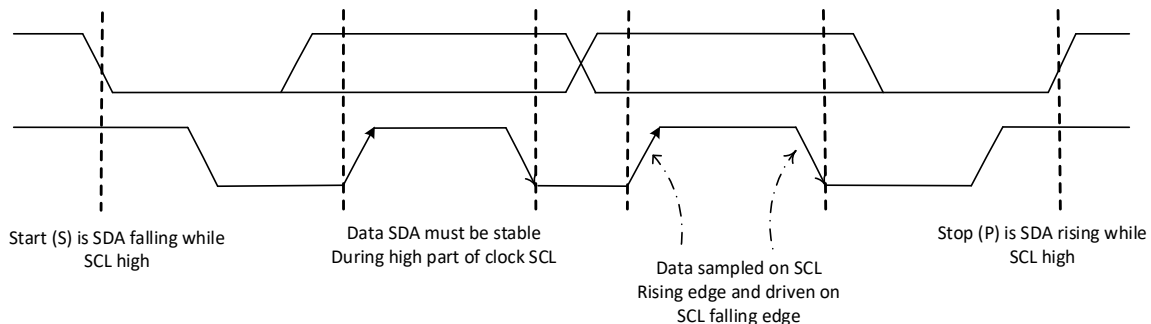
The host processor provides the serial clock at the SCL pin. DA9281 supports I²C standard-mode (100 Kbit/s) and up to 400 Kbit/s (fast-mode) as described in the I²C-bus specification Rev 06 (UM1010204, issued on 4 April 2014).

The DA9281 8-bit SLAVE address is 0xA2h (default).

The I²C data pin, SDA, is open drain allowing multiple devices to share a communication line.

The I²C interface uses a two-byte serial protocol containing one byte for address and one byte for data. The data and address are transferred with MSB transmitted first for both read and write operations.

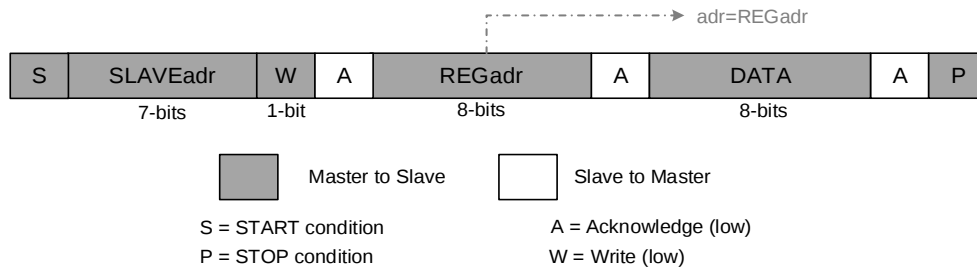
All transmissions begin with a START condition issued from the master while the bus is in an IDLE state (that is, the bus is free). The START condition is initiated by a high to low transition on the SDA line while the SCL is in the high state. A STOP condition is indicated by a low to high transition on the SDA line while the SCL line is in the high state.

Figure 36. I²C Start (S) and Stop (P)

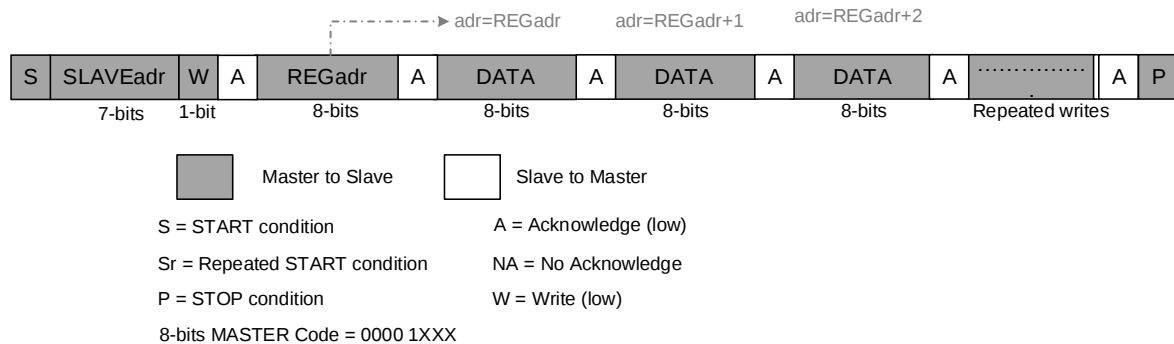
DA9281 monitors the serial bus for a valid SLAVE address whenever the interface is enabled. When it receives its own slave address, it immediately gives an acknowledge signal to the host by pulling the SDA line low during the following clock cycle.

A Not Acknowledge signal is given by the logic 1, not pulling down the SDA line.

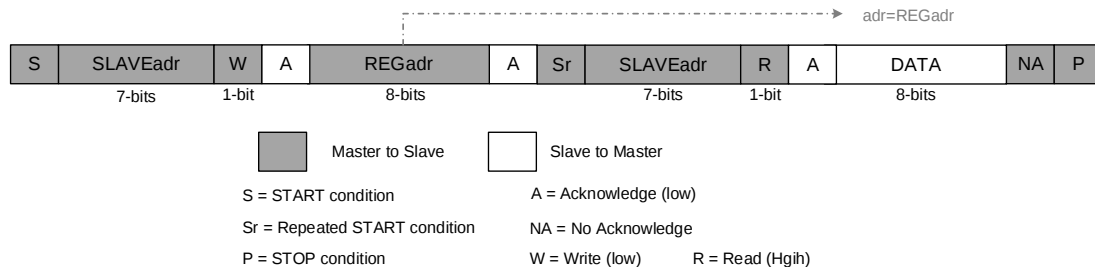
A single-byte write is shown in Figure 37. The slave address is followed by a WRITE bit (low), the register address, and the data. The transaction is terminated with a STOP.

**Figure 37. Single Write Command**

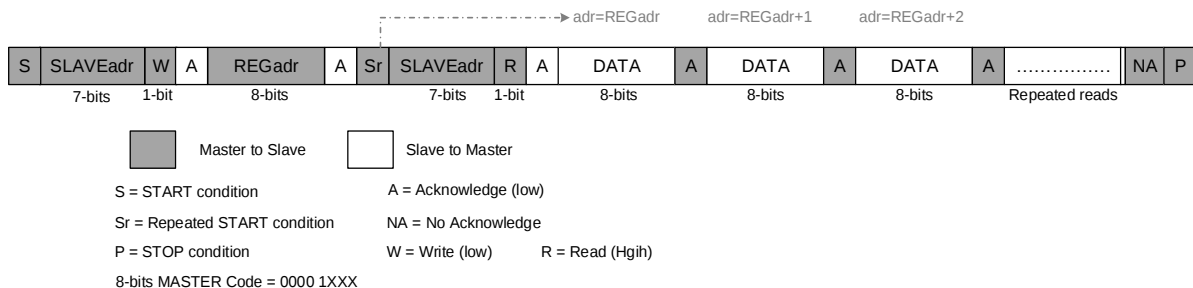
DA9281 also supports multiple byte writes, see [Figure 38](#). By not sending the STOP command, data is written to consecutive addresses.

**Figure 38. Consecutive Write Command**

The data READ protocol does not have a register address immediately preceding it. To read from a specific address, the register address is given by using a write command followed by a Repeated START. A single byte read is shown in [Figure 39](#). A Repeated START is followed by the slave address and a READ bit. After the READ data is returned to the host, the host responds with a Not Acknowledge and a STOP.

**Figure 39. Single Read Command**

DA9281 also supports a multiple byte reads. If the host responds to the returned data with an Acknowledge rather than a No Acknowledge and a STOP, then data will be read from sequential addresses until a No Acknowledge and a STOP command are given, as shown in [Figure 40](#). If a READ address is given with a WRITE and Repeated START, consecutive addresses are read from the WRITE address.

**Figure 40. Consecutive Read Command**

7. Register Definitions

NOTE

The following registers are password protected.

- PMC_VOUT_ADJUST
- PMC_CONTROL_00
- PMC_CONTROL_01
- PMC_CONTROL_02
- PMC_CH1_VOUT_INT
- PMC_CH2_VOUT_INT
- PMC_CH3_VOUT_INT
- PMC_CH4_VOUT_INT
- PMC_CONFIG_00
- PMC_CONFIG_0B
- BUCK_BUCK_OTP_04
- BUCK_BUCK_OTP_05
- BUCK_BUCK_OTP_06
- BUCK_BUCK_OTP_07

I²C access is required to unlock those registers. Write the following sequence:

Write 0x00 to address 0x3E

Write 0xB0 to address 0x3F

Write 0xA9 to address 0x3F

Write 0x8A to address 0x3F

Write 0xA7 to address 0x3F

Write 0xA8 to address 0x3F

Write 0xB1 to address 0x3F

To lock those registers, write the following sequence:

Write 0x00 to address 0x3E

Write 0x00 to address 0x3F

7.1 Register Map

Table 18. Register Map

Address	Register	Description
0x01	PMC_VOUT_ADJUST	Output voltage selection for CH7
0x02	PMC_DISCHARGE	Pulldown selection
0x03	PMC_SOFT_START_1	Soft-start time select for CH1, CH2, CH3, CH4
0x04	PMC_SOFT_START_2	Soft-start time select for CH5, CH6, CH7, CH8
0x05	PMC_ENABLE_DELAY_1	Enable delay for CH1, CH2, CH3, CH4
0x06	PMC_ENABLE_DELAY_2	Enable delay for CH6, CH7, CH8
0x07	PMC_DISENDLY	Disable delay for CH1, CH2, CH3, CH4, CH6, CH7, CH8
0x08	PMC_PROT_STATUS_1	OVP/UVLP status of CH1, CH2, CH3, CH4
0x09	PMC_PROT_STATUS_2	OVP/UVLP status of CH5, CH6, CH7, CH8
0x0A	PMC_STATUS	PG status for CH1, CH2, CH3, CH4; UVLO, VDD_FAULT and TEMP_CRIT status
0x0C	PMC_CONTROL_00	Enable for CH1, CH2, CH3, CH4, CH5, CH6, CH7, CH8
0x0D	PMC_CONTROL_01	Operating mode for CH1, CH2, CH3, CH4

Address	Register	Description
0x0E	PMC_CONTROL_02	Sequence enable for CH1, CH2, CH3, CH4, CH5, CH6, CH7, CH8
0x0F	PMC_CH1_VOUT_INT	VOUT setting for CH1
0x10	PMC_CH2_VOUT_INT	VOUT setting for CH2
0x11	PMC_CH3_VOUT_INT	VOUT setting for CH3
0x12	PMC_CH4_VOUT_INT	VOUT setting for CH4
0x14	PMC_CONFIG_00	I2C slave address
0x1F	PMC_CONFIG_0B	Sequencer enable
0x41	OTP_VARIANT_ID	Silicon revision
0x42	OTP_CUSTOMER_ID	OTP file version
0x43	OTP_CONFIG_ID	OTP variant
0x4C	BUCK_BUCK_OTP_04	Divider mode enable for CH1
0x4D	BUCK_BUCK_OTP_05	Divider mode enable for CH2
0x4E	BUCK_BUCK_OTP_06	Divider mode enable for CH3
0x4F	BUCK_BUCK_OTP_07	Divider mode enable for CH4

7.2 Register Details

Table 19. Register Details

Address	Register	Bit	Type	Function	Detail	Default
0x01	PMC_VOUT_ADJUST	[7:6]	R/W	RESERVED	-	0x0
		[5:2]	R/W	RESERVED	-	0x2
		1	R/W	CH7_VOUT	0: 1.8 V 1: 3.3 V	0x1
		0	R/W	RESERVED	-	0x0
0x02	PMC_DISCHARGE	7	R/W	CH1_DISCH	0: Discharge Disable 1: Discharge enable	0x1
		6	R/W	CH2_DISCH	0: Discharge Disable 1: Discharge enable	0x1
		5	R/W	CH3_DISCH	0: Discharge Disable 1: Discharge enable	0x1
		4	R/W	CH4_DISCH	0: Discharge Disable 1: Discharge enable	0x1
		3	R/W	CH5_DISCH	0: Hi-Z 1: Discharge enable	0x1
		2	R/W	CH6_DISCH	0: Discharge Disable 1: Discharge enable	0x1
		1	R/W	CH7_DISCH	0: Discharge Disable 1: Discharge enable	0x1
		0	R/W	CH8_DISCH	0: Discharge Disable 1: Discharge enable	0x1
0x03	PMC_SOFT_START_1	[7:6]	R/W	CH1_SS	00: 0.4 ms 01: 0.6 ms 10: 0.8 ms 11: Reserved	0x1
		[5:4]	R/W	CH2_SS	00: 0.4 ms 01: 0.6 ms 10: 0.8 ms 11: Reserved	0x1

Address	Register	Bit	Type	Function	Detail	Default
		[3:2]	R/W	CH3_SS	00: 0.4 ms 01: 0.6 ms 10: 0.8 ms 11: Reserved	0x1
		[1:0]	R/W	CH4_SS	00: 0.4 ms 01: 0.6 ms 10: 0.8 ms 11: Reserved	0x1
0x04	PMC_SOFT_START_2	[7:6]	R/W	CH5_SS	00: 0.4 ms 01: 0.6 ms 10: 0.8 ms 11: Reserved	0x1
		[5:4]	R/W	CH6_SS	00: 0.4 ms 01: 0.6 ms 10: 0.8 ms 11: Reserved	0x1
		[3:2]	R/W	CH7_SS	00: 0.4 ms 01: 0.6 ms 10: 0.8 ms 11: Reserved	0x1
		[1:0]	R/W	CH8_SS	00: 0.4 ms 01: 0.6 ms 10: 0.8 ms 11: Reserved	0x1
0x05	PMC_ENABLE_DELAY_1	[7:6]	R/W	CH1_ENDLY	00: 0.0 ms 01: 0.8 ms 10: 1.6 ms 11: 2.4 ms	0x0
		[5:4]	R/W	CH2_ENDLY	00: 0.0 ms 01: 0.8 ms 10: 1.6 ms 11: 2.4 ms	0x0
		[3:2]	R/W	CH3_ENDLY	00: 0.0 ms 01: 0.8 ms 10: 1.6 ms 11: 2.4 ms	0x0
		[1:0]	R/W	CH4_ENDLY	00: 0.0 ms 01: 0.8 ms 10: 1.6 ms 11: 2.4 ms	0x0
0x06	PMC_ENABLE_DELAY_2	[7:6]	R/W	RESERVED	-	0x0
		[5:4]	R/W	CH6_ENDLY	00: 0.0 ms 01: 0.8 ms 10: 1.6 ms 11: 2.4 ms	0x0
		[3:2]	R/W	CH7_ENDLY	00: 0.0 ms 01: 0.8 ms 10: 1.6 ms 11: 2.4 ms	0x0

Address	Register	Bit	Type	Function	Detail	Default
		[1:0]	R/W	CH8_ENDLY	00: 0.0 ms 01: 0.8 ms 10: 1.6 ms 11: 2.4 ms	0x0
0x07	PMC_DISENDLY	7	R/W	CH1_DISENDLY	0: 0 ms 1: 10 ms	0x0
		6	R/W	CH2_DISENDLY	0: 0 ms 1: 10 ms	0x0
		5	R/W	CH3_DISENDLY	0: 0 ms 1: 10 ms	0x0
		4	R/W	CH4_DISENDLY	0: 0 ms 1: 10 ms	0x0
		3	R/W	RESERVED	-	0x0
		2	R/W	CH6_DISENDLY	0: 0 ms 1: 10 ms	0x0
		1	R/W	CH7_DISENDLY	0: 0 ms 1: 10 ms	0x0
		0	R/W	CH8_DISENDLY	0: 0ms 1: 10ms	0x0
0x08	PMC_PROT_STATUS_1	[7:6]	R	CH1_STATUS	00: Normal 01: Reserved 10: UVP 11: OVP	0x0
		[5:4]	R	CH2_STATUS	00: Normal 01: Reserved 10: UVP 11: OVP	0x0
		[3:2]	R	CH3_STATUS	00: Normal 01: Reserved 10: UVP 11: OVP	0x0
		[1:0]	R	CH4_STATUS	00: Normal 01: Reserved 10: UVP 11: OVP	0x0
0x09	PMC_PROT_STATUS_2	[7:6]	R	CH5_STATUS	00: Normal 01: Reserved 10: UVP 11: OVP	0x0
		[5:4]	R	CH6_STATUS	00: Normal 01: Reserved 10: UVP 11: OVP	0x0
		[3:2]	R	CH7_STATUS	00: Normal 01: Reserved 10: UVP 11: OVP	0x0
		[1:0]	R	CH8_STATUS	00: Normal 01: Reserved	0x0

Address	Register	Bit	Type	Function	Detail	Default
					10: UVP 11: OVP	
0x0A	PMC_STATUS_00	7	R	S_CH1_PG	CH1 PG status	0x0
		6	R	S_CH2_PG	CH2 PG status	0x0
		5	R	S_CH3_PG	CH3 PG status	0x0
		4	R	S_CH4_PG	CH4 PG status	0x0
		3	R	RESERVED	-	0x0
		2	R	S_UVLO	VIN UV status	0x0
		1	R	S_VDD_FAULT	VDD_FAULT status	0x0
		0	R	S_TEMP_CRIT	Thermal shutdown status	0x0
0x0C	PMC_CONTROL_00	7	R/W	CH1_EN	CH1 enable	0x0
		6	R/W	CH2_EN	CH2 enable	0x0
		5	R/W	CH3_EN	CH3 enable	0x0
		4	R/W	CH4_EN	CH4 enable	0x0
		3	R/W	CH5_EN	CH5 enable	0x0
		2	R/W	CH6_EN	CH6 enable	0x0
		1	R/W	CH7_EN	CH7 enable	0x0
		0	R/W	CH8_EN	CH8 enable	0x0
0x0D	PMC_CONTROL_01	7	R/W	RESERVED	-	0x0
		6	R/W	RESERVED	-	0x0
		5	R/W	RESERVED	-	0x0
		4	R/W	RESERVED	-	0x0
		3	R/W	CH1_MODE	CH1 Mode 0: Auto-mode 1: Force-PWM	0x0
		2	R/W	CH2_MODE	CH2 Mode 0: Auto-mode 1: Force-PWM	0x0
		1	R/W	CH3_MODE	CH3 Mode 0: Auto-mode 1: Force-PWM	0x0
		0	R/W	CH4_MODE	CH4 Mode 0: Auto-mode 1: Force-PWM	0x0
0x0E	PMC_CONTROL_02	7	R/W	CH1_SEQ_DIS	0: Enabled by sequencer 1: Not enabled by sequencer	0x0
		6	R/W	CH2_SEQ_DIS	0: Enabled by sequencer 1: Not enabled by sequencer	0x0
		5	R/W	CH3_SEQ_DIS	0: Enabled by sequencer	0x0

Address	Register	Bit	Type	Function	Detail	Default
					1: Not enabled by sequencer	
		4	R/W	CH4_SEQ_DIS	0: Enabled by sequencer 1: Not enabled by sequencer	0x0
		3	R/W	CH5_SEQ_DIS	0: Enabled by sequencer 1: Not enabled by sequencer	0x0
		2	R/W	CH6_SEQ_DIS	0: Enabled by sequencer 1: Not enabled by sequencer	0x0
		1	R/W	CH7_SEQ_DIS	0: Enabled by sequencer 1: Not enabled by sequencer	0x0
		0	R/W	CH8_SEQ_DIS	0: Enabled by sequencer 1: Not enabled by sequencer	0x0
0x0F	PMC_CH1_VOUT	[7:0]	R/W	CH1_VOUT_INT	CH1 output voltage (V) Format is (without divider)/(with divider) Value Description 0x00: Reserved ... 0x4F: Reserved 0x50: 0.80/1.60 0x51: 0.81/1.62 0x52: 0.82/1.64 0x53: 0.83/1.66 0x54: 0.84/1.68 0x55: 0.85/1.70 0x56: 0.86/1.72 0x57: 0.87/1.74 0x58: 0.88/1.76 0x59: 0.89/1.78 0x5A: 0.90/1.80 0x5B: 0.91/1.82 0x5C: 0.92/1.84 0x5D: 0.93/1.86 0x5E: 0.94/1.88 0x5F: 0.95/1.90 0x60: 0.96/1.92 0x61: 0.97/1.94 0x62: 0.98/1.96 0x63: 0.99/1.98 0x64: 1.00/2.00 0x65: 1.01/2.02 0x66: 1.02/2.04 0x67: 1.03/2.06	0x50

Address	Register	Bit	Type	Function	Detail	Default
					0x68: 1.04/2.08 0x69: 1.05/2.10 0x6A: 1.06/2.12 0x6B: 1.07/2.14 0x6C: 1.08/2.16 0x6D: 1.09/2.18 0x6E: 1.10/2.20 0x6F: 1.11/2.22 0x70: 1.12/2.24 0x71: 1.13/2.26 0x72: 1.14/2.28 0x73: 1.15/2.30 0x74: 1.16/2.32 0x75: 1.17/2.34 0x76: 1.18/2.36 0x77: 1.19/2.38 0x78: 1.20/2.40 0x79: 1.21/2.42 0x7A: 1.22/2.44 0x7B: 1.23/2.46 0x7C: 1.24/2.48 0x7D: 1.25/2.50 0x7E: 1.26/2.52 0x7F: 1.27/2.54 0x80: 1.28/2.56 0x81: 1.29/2.58 0x82: 1.30/2.60 0x83: 1.31/2.62 0x84: 1.32/2.64 0x85: 1.33/2.66 0x86: 1.34/2.68 0x87: 1.35/2.70 0x88: 1.36/2.72 0x89: 1.37/2.74 0x8A: 1.38/2.76 0x8B: 1.39/2.78 0x8C: 1.40/2.8 0x8D: 1.41/2.82 0x8E: 1.42/2.84 0x8F: 1.43/2.86 0x90: 1.44/2.88 0x91: 1.45/2.9 0x92: 1.46/2.92 0x93: 1.47/2.94 0x94: 1.48/2.96 0x95: 1.49/2.98 0x96: 1.50/3 0x97: 1.51/Reserved	

Address	Register	Bit	Type	Function	Detail	Default
					0x98: 1.52/Reserved 0x99: 1.53/Reserved 0x9A: 1.54/Reserved 0x9B: 1.55/Reserved 0x9C: 1.56/Reserved 0x9D: 1.57/Reserved 0x9E: 1.58/Reserved 0x9F: 1.59/Reserved 0xA0: 1.60/Reserved 0xA1: 1.61/Reserved 0xA2: 1.62/Reserved 0xA3: 1.63/Reserved 0xA4: 1.64/Reserved 0xA5: 1.65/Reserved 0xA6: 1.66/Reserved 0xA7: 1.67/Reserved 0xA8: 1.68/Reserved 0xA9: 1.69/Reserved 0xAA: 1.7/Reserved 0xAB: 1.71/Reserved 0xAC: 1.72/Reserved 0xAD: 1.73/Reserved 0xAE: 1.74/Reserved 0xAF: 1.75/Reserved 0xB0: 1.76/Reserved 0xB1: 1.77/Reserved 0xB2: 1.78/Reserved 0xB3: 1.79/Reserved 0xB4: 1.8/Reserved 0xB5: 1.81/Reserved 0xB6: 1.82/Reserved 0xB7: 1.83/Reserved 0xB8: 1.84/Reserved 0xB9: 1.85/Reserved 0xBA: 1.86/Reserved 0xBB: 1.87/Reserved 0xBC: 1.88/Reserved 0xBD: 1.89/Reserved 0xBE: 1.9/Reserved 0xBF: 1.91/Reserved 0xC0: 1.92/Reserved 0xC1: 1.93/Reserved 0xC2: 1.94/Reserved 0xC3: 1.95/Reserved 0xC4: 1.96/Reserved 0xC5: 1.97/Reserved 0xC6: 1.98/Reserved 0xC7: 1.99/Reserved	

Address	Register	Bit	Type	Function	Detail	Default
					0xC8: 2/Reserved 0xC9: 2.01/Reserved 0xCA: 2.02/Reserved 0xCB: 2.03/Reserved 0xCC: 2.04/Reserved 0xCD: 2.05/Reserved 0xCE: 2.06/Reserved 0xCF: 2.07/Reserved 0xD0: 2.08/Reserved 0xD1: 2.09/Reserved 0xD2: 2.1/Reserved 0xD3: 2.11/Reserved 0xD4: 2.12/Reserved 0xD5: 2.13/Reserved 0xD6: 2.14/Reserved 0xD7: 2.15/Reserved 0xD8: 2.16/Reserved 0xD9: 2.17/Reserved 0xDA: 2.18/Reserved 0xDB: 2.19/Reserved 0xDC: 2.2/Reserved 0xDD: Reserved ... 0xFF: Reserved	
0x10	PMC_CH2_VOUT	[7:0]	R/W	CH2_VOUT_INT	CH2 output voltage (V) Format is (without divider)/(with divider) Value Description 0x00: Reserved ... 0x4F: Reserved 0x50: 0.80/1.60 0x51: 0.81/1.62 0x52: 0.82/1.64 0x53: 0.83/1.66 0x54: 0.84/1.68 0x55: 0.85/1.70 0x56: 0.86/1.72 0x57: 0.87/1.74 0x58: 0.88/1.76 0x59: 0.89/1.78 0x5A: 0.90/1.80 0x5B: 0.91/1.82 0x5C: 0.92/1.84 0x5D: 0.93/1.86 0x5E: 0.94/1.88 0x5F: 0.95/1.90 0x60: 0.96/1.92	0x50

Address	Register	Bit	Type	Function	Detail	Default
					0x61: 0.97/1.94 0x62: 0.98/1.96 0x63: 0.99/1.98 0x64: 1.00/2.00 0x65: 1.01/2.02 0x66: 1.02/2.04 0x67: 1.03/2.06 0x68: 1.04/2.08 0x69: 1.05/2.10 0x6A: 1.06/2.12 0x6B: 1.07/2.14 0x6C: 1.08/2.16 0x6D: 1.09/2.18 0x6E: 1.10/2.20 0x6F: 1.11/2.22 0x70: 1.12/2.24 0x71: 1.13/2.26 0x72: 1.14/2.28 0x73: 1.15/2.30 0x74: 1.16/2.32 0x75: 1.17/2.34 0x76: 1.18/2.36 0x77: 1.19/2.38 0x78: 1.20/2.40 0x79: 1.21/2.42 0x7A: 1.22/2.44 0x7B: 1.23/2.46 0x7C: 1.24/2.48 0x7D: 1.25/2.50 0x7E: 1.26/2.52 0x7F: 1.27/2.54 0x80: 1.28/2.56 0x81: 1.29/2.58 0x82: 1.30/2.60 0x83: 1.31/2.62 0x84: 1.32/2.64 0x85: 1.33/2.66 0x86: 1.34/2.68 0x87: 1.35/2.70 0x88: 1.36/2.72 0x89: 1.37/2.74 0x8A: 1.38/2.76 0x8B: 1.39/2.78 0x8C: 1.40/2.8 0x8D: 1.41/2.82 0x8E: 1.42/2.84 0x8F: 1.43/2.86 0x90: 1.44/2.88	

Address	Register	Bit	Type	Function	Detail	Default
					0x91: 1.45/2.9 0x92: 1.46/2.92 0x93: 1.47/2.94 0x94: 1.48/2.96 0x95: 1.49/2.98 0x96: 1.50/3 0x97: 1.51/3.02 0x98: 1.52/3.04 0x99: 1.53/3.06 0x9A: 1.54/3.08 0x9B: 1.55/3.1 0x9C: 1.56/3.12 0x9D: 1.57/3.14 0x9E: 1.58/3.16 0x9F: 1.59/3.18 0xA0: 1.60/3.2 0xA1: 1.61/3.22 0xA2: 1.62/3.24 0xA3: 1.63/3.26 0xA4: 1.64/3.28 0xA5: 1.65/3.3 0xA6: 1.66/Reserved 0xA7: 1.67/Reserved 0xA8: 1.68/Reserved 0xA9: 1.69/Reserved 0xAA: 1.7/Reserved 0xAB: 1.71/Reserved 0xAC: 1.72/Reserved 0xAD: 1.73/Reserved 0xAE: 1.74/Reserved 0xAF: 1.75/Reserved 0xB0: 1.76/Reserved 0xB1: 1.77/Reserved 0xB2: 1.78/Reserved 0xD0: 2.08/Reserved 0xD1: 2.09/Reserved 0xD2: 2.1/Reserved 0xD3: 2.11/Reserved 0xD4: 2.12/Reserved 0xD5: 2.13/Reserved 0xD6: 2.14/Reserved 0xD7: 2.15/Reserved 0xD8: 2.16/Reserved 0xD9: 2.17/Reserved 0xDA: 2.18/Reserved 0xDB: 2.19/Reserved 0xB3: 1.79/Reserved 0xB4: 1.8/Reserved	

Address	Register	Bit	Type	Function	Detail	Default
					0xB5: 1.81/Reserved 0xB6: 1.82/Reserved 0xB7: 1.83/Reserved 0xB8: 1.84/Reserved 0xB9: 1.85/Reserved 0xBA: 1.86/Reserved 0xBB: 1.87/Reserved 0xBC: 1.88/Reserved 0xBD: 1.89/Reserved 0xBE: 1.9/Reserved 0xBF: 1.91/Reserved 0xC0: 1.92/Reserved 0xC1: 1.93/Reserved 0xC2: 1.94/Reserved 0xC3: 1.95/Reserved 0xC4: 1.96/Reserved 0xC5: 1.97/Reserved 0xC6: 1.98/Reserved 0xC7: 1.99/Reserved 0xC8: 2/Reserved 0xC9: 2.01/Reserved 0xCA: 2.02/Reserved 0xCB: 2.03/Reserved 0xCC: 2.04/Reserved 0xCD: 2.05/Reserved 0xCE: 2.06/Reserved 0xCF: 2.07/Reserved 0xDC: 2.2/Reserved 0xDD: Reserved ... 0xFF: Reserved	
0x11	PMC_CH3_VOUT	[7:0]	R/W	CH3_VOUT_INT	CH3 output voltage (V) Format is (without divider)/(with divider) Value Description 0x00: Reserved ... 0x4F: Reserved 0x50: 0.80/1.60 0x51: 0.81/1.62 0x52: 0.82/1.64 0x53: 0.83/1.66 0x54: 0.84/1.68 0x55: 0.85/1.70 0x56: 0.86/1.72 0x57: 0.87/1.74 0x58: 0.88/1.76	0x50

Address	Register	Bit	Type	Function	Detail	Default
					0x59: 0.89/1.78 0x5A: 0.90/1.80 0x5B: 0.91/1.82 0x5C: 0.92/1.84 0x5D: 0.93/1.86 0x5E: 0.94/1.88 0x5F: 0.95/1.90 0x60: 0.96/1.92 0x61: 0.97/1.94 0x62: 0.98/1.96 0x63: 0.99/1.98 0x64: 1.00/2.00 0x65: 1.01/2.02 0x66: 1.02/2.04 0x67: 1.03/2.06 0x68: 1.04/2.08 0x69: 1.05/2.10 0x6A: 1.06/2.12 0x6B: 1.07/2.14 0x6C: 1.08/2.16 0x6D: 1.09/2.18 0x6E: 1.10/2.20 0x6F: 1.11/2.22 0x70: 1.12/2.24 0x71: 1.13/2.26 0x72: 1.14/2.28 0x73: 1.15/2.30 0x74: 1.16/2.32 0x75: 1.17/2.34 0x76: 1.18/2.36 0x77: 1.19/2.38 0x78: 1.20/2.40 0x79: 1.21/2.42 0x7A: 1.22/2.44 0x7B: 1.23/2.46 0x7C: 1.24/2.48 0x7D: 1.25/2.50 0x7E: 1.26/2.52 0x7F: 1.27/2.54 0x80: 1.28/2.56 0x81: 1.29/2.58 0x82: 1.30/2.60 0x83: 1.31/2.62 0x84: 1.32/2.64 0x85: 1.33/2.66 0x86: 1.34/2.68 0x87: 1.35/2.70 0x88: 1.36/2.72	

Address	Register	Bit	Type	Function	Detail	Default
					0x89: 1.37/2.74 0x8A: 1.38/2.76 0x8B: 1.39/2.78 0x8C: 1.40/2.8 0x8D: 1.41/2.82 0x8E: 1.42/2.84 0x8F: 1.43/2.86 0x90: 1.44/2.88 0x91: 1.45/2.9 0x92: 1.46/2.92 0x93: 1.47/2.94 0x94: 1.48/2.96 0x95: 1.49/2.98 0x96: 1.50/3 0x97: 1.51/3.02 0x98: 1.52/3.04 0x99: 1.53/3.06 0x9A: 1.54/3.08 0x9B: 1.55/3.1 0x9C: 1.56/3.12 0x9D: 1.57/3.14 0x9E: 1.58/3.16 0x9F: 1.59/3.18 0xA0: 1.60/3.2 0xA1: 1.61/3.22 0xA2: 1.62/3.24 0xA3: 1.63/3.26 0xA4: 1.64/3.28 0xA5: 1.65/3.3 0xA6: 1.66/3.32 0xA7: 1.67/3.34 0xA8: 1.68/3.36 0xA9: 1.69/3.38 0xAA: 1.70/3.4 0xAB: 1.71/3.42 0xAC: 1.72/3.44 0xAD: 1.73/3.46 0xAE: 1.74/3.48 0xAF: 1.75/3.5 0xB0: 1.76/3.52 0xB1: 1.77/3.54 0xB2: 1.78/3.56 0xB3: 1.79/3.58 0xB4: 1.80/3.6 0xB5: 1.81/Reserved 0xB6: 1.82/Reserved 0xB7: 1.83/Reserved 0xB8: 1.84/Reserved	

Address	Register	Bit	Type	Function	Detail	Default
					0xB9: 1.85/Reserved 0xBA: 1.86/Reserved 0xBB: 1.87/Reserved 0xBC: 1.88/Reserved 0xBD: 1.89/Reserved 0xBE: 1.9/Reserved 0xBF: 1.91/Reserved 0xC0: 1.92/Reserved 0xC1: 1.93/Reserved 0xC2: 1.94/Reserved 0xC3: 1.95/Reserved 0xC4: 1.96/Reserved 0xC5: 1.97/Reserved 0xC6: 1.98/Reserved 0xC7: 1.99/Reserved 0xC8: 2/Reserved 0xC9: 2.01/Reserved 0xCA: 2.02/Reserved 0xCB: 2.03/Reserved 0xCC: 2.04/Reserved 0xCD: 2.05/Reserved 0xCE: 2.06/Reserved 0xCF: 2.07/Reserved 0xD0: 2.08/Reserved 0xD1: 2.09/Reserved 0xD2: 2.1/Reserved 0xD3: 2.11/Reserved 0xD4: 2.12/Reserved 0xD5: 2.13/Reserved 0xD6: 2.14/Reserved 0xD7: 2.15/Reserved 0xD8: 2.16/Reserved 0xD9: 2.17/Reserved 0xDA: 2.18/Reserved 0xDB: 2.19/Reserved 0xDC: 2.2/Reserved 0xDD: Reserved ... 0xFF: Reserved	
0x12	PMC_CH4_VOUT	7	R/W	CH4_VOUT_INT	CH4 output voltage (V) Format is (without divider)/(with divider) Value Description 0x00: Reserved ... 0x4F: Reserved 0x50: 0.80/1.60 0x51: 0.81/1.62	0x50

Address	Register	Bit	Type	Function	Detail	Default
					0x52: 0.82/1.64 0x53: 0.83/1.66 0x54: 0.84/1.68 0x55: 0.85/1.70 0x56: 0.86/1.72 0x57: 0.87/1.74 0x58: 0.88/1.76 0x59: 0.89/1.78 0x5A: 0.90/1.80 0x5B: 0.91/1.82 0x5C: 0.92/1.84 0x5D: 0.93/1.86 0x5E: 0.94/1.88 0x5F: 0.95/1.90 0x60: 0.96/1.92 0x61: 0.97/1.94 0x62: 0.98/1.96 0x63: 0.99/1.98 0x64: 1.00/2.00 0x65: 1.01/2.02 0x66: 1.02/2.04 0x67: 1.03/2.06 0x68: 1.04/2.08 0x69: 1.05/2.10 0x6A: 1.06/2.12 0x6B: 1.07/2.14 0x6C: 1.08/2.16 0x6D: 1.09/2.18 0x6E: 1.10/2.20 0x6F: 1.11/2.22 0x70: 1.12/2.24 0x71: 1.13/2.26 0x72: 1.14/2.28 0x73: 1.15/2.30 0x74: 1.16/2.32 0x75: 1.17/2.34 0x76: 1.18/2.36 0x77: 1.19/2.38 0x78: 1.20/2.40 0x79: 1.21/2.42 0x7A: 1.22/2.44 0x7B: 1.23/2.46 0x7C: 1.24/2.48 0x7D: 1.25/2.50 0x7E: 1.26/2.52 0x7F: 1.27/2.54 0x80: 1.28/2.56 0x81: 1.29/2.58	

Address	Register	Bit	Type	Function	Detail	Default
					0x82: 1.30/2.60 0x83: 1.31/2.62 0x84: 1.32/2.64 0x85: 1.33/2.66 0x86: 1.34/2.68 0x87: 1.35/2.70 0x88: 1.36/2.72 0x89: 1.37/2.74 0x8A: 1.38/2.76 0x8B: 1.39/2.78 0x8C: 1.40/2.8 0x8D: 1.41/2.82 0x8E: 1.42/2.84 0x8F: 1.43/2.86 0x90: 1.44/2.88 0x91: 1.45/2.9 0x92: 1.46/2.92 0x93: 1.47/2.94 0x94: 1.48/2.96 0x95: 1.49/2.98 0x96: 1.50/3 0x97: 1.51/3.02 0x98: 1.52/3.04 0x99: 1.53/3.06 0x9A: 1.54/3.08 0x9B: 1.55/3.1 0x9C: 1.56/3.12 0x9D: 1.57/3.14 0x9E: 1.58/3.16 0x9F: 1.59/3.18 0xA0: 1.60/3.2 0xA1: 1.61/3.22 0xA2: 1.62/3.24 0xA3: 1.63/3.26 0xA4: 1.64/3.28 0xA5: 1.65/3.3 0xA6: 1.66/Reserved 0xA7: 1.67/Reserved 0xA8: 1.68/Reserved 0xA9: 1.69/Reserved 0xAA: 1.7/Reserved 0xAB: 1.71/Reserved 0xAC: 1.72/Reserved 0xAD: 1.73/Reserved 0xAE: 1.74/Reserved 0xAF: 1.75/Reserved 0xB0: 1.76/Reserved 0xB1: 1.77/Reserved	

Address	Register	Bit	Type	Function	Detail	Default
					0xB2: 1.78/Reserved 0xB3: 1.79/Reserved 0xB4: 1.8/Reserved 0xB5: 1.81/Reserved 0xB6: 1.82/Reserved 0xB7: 1.83/Reserved 0xB8: 1.84/Reserved 0xB9: 1.85/Reserved 0xBA: 1.86/Reserved 0xBB: 1.87/Reserved 0xBC: 1.88/Reserved 0xBD: 1.89/Reserved 0xBE: 1.9/Reserved 0xBF: 1.91/Reserved 0xC0: 1.92/Reserved 0xC1: 1.93/Reserved 0xC2: 1.94/Reserved 0xC3: 1.95/Reserved 0xC4: 1.96/Reserved 0xC5: 1.97/Reserved 0xC6: 1.98/Reserved 0xC7: 1.99/Reserved 0xC8: 2/Reserved 0xC9: 2.01/Reserved 0xCA: 2.02/Reserved 0xCB: 2.03/Reserved 0xCC: 2.04/Reserved 0xCD: 2.05/Reserved 0xCE: 2.06/Reserved 0xCF: 2.07/Reserved 0xD0: 2.08/Reserved 0xD1: 2.09/Reserved 0xD2: 2.1/Reserved 0xD3: 2.11/Reserved 0xD4: 2.12/Reserved 0xD5: 2.13/Reserved 0xD6: 2.14/Reserved 0xD7: 2.15/Reserved 0xD8: 2.16/Reserved 0xD9: 2.17/Reserved 0xDA: 2.18/Reserved 0xDB: 2.19/Reserved 0xDC: 2.2/Reserved 0xDD: Reserved ... 0xFF: Reserved	
0x14	PMC_CONFIG_00	[7:1]	R/W	I2C_SLAVE_ADD R	I2C slave address	0xA2

Address	Register	Bit	Type	Function	Detail	Default
		0	R/W	I2C_FMP	I2C mode 0: Fast-mode or standard mode 1: Fast-mode-plus	0x0
0x1F	PMC_CONFIG_0B	[7:4]	R/W	RESERVED	-	0xE
		3	R/W	SEQ_EN	0: Disable (channels not enabled) 1: Enable (SEQ runs to enable channels)	0x0
		[2:0]	R/W	RESERVED	-	0x1
0x41	OTP_VARIANT_ID	[7:4]	R	MRC	Silicon revision	0x0
		[3:0]	R/W	VRC	0: ASIC 2: ASSP	0x2
0x42	OTP_CUSTOMER_ID	[7:0]	R/W	CUST_ID	OTP file version	0x0
0x43	OTP_CONFIG_ID	[7:0]	R/W	CONFIG_REV	OTP variant	0x0
0x4C	BUCK_BUCK_OPT_04	7	R/W	BUCK1_OPT_CT RL6	Enable resistive divider on FB to double VOUT: 0: Divider disable 1: Divider enable	0x0
		[6:0]	R/W	RESERVED	-	0x20
0x4D	BUCK_BUCK_OPT_05	7	R/W	BUCK2_OPT_CT RL6	Enable resistive divider on FB to double VOUT: 0: Divider disable 1: Divider enable	0x0
		[6:0]	R/W	RESERVED	-	0x28
0x4E	BUCK_BUCK_OPT_06	7	R/W	BUCK3_OPT_CT RL6	Enable resistive divider on FB to double VOUT: 0: Divider disable 1: Divider enable	0x0
		[6:0]	R/W	RESERVED	-	0x28
0x4F	BUCK_BUCK_OPT_07	7	R/W	BUCK4_OPT_CT RL6	Enable resistive divider on FB to double VOUT: 0: Divider disable 1: Divider enable	0x0
		[6:0]	R/W	RESERVED	-	0x28

8. Package Information

8.1 Package Outlines

The package outline drawings are located at the end of this document and are accessible from the Renesas website. The package information is the most current data available and is subject to change without revision of this document.

8.2 Moisture Sensitivity Level

The Moisture Sensitivity Level (MSL) is an indicator for the maximum allowable time period (floor lifetime) in which a moisture sensitive plastic device, once removed from the dry bag, can be exposed to an environment with a specified maximum temperature and a maximum relative humidity before the solder reflow process. The MSL classification is defined in [Table 20](#).

For detailed information on MSL levels refer to the IPC/JEDEC standard J-STD-020, which can be downloaded from <http://www.jedec.org>.

The package is qualified for MSL 3.

Table 20. MSL Classification

MSL Level	Floor Lifetime	Conditions
MSL 4	72 hours	30 °C / 60 % RH
MSL 3	168 hours	30 °C / 60 % RH
MSL 2A	4 weeks	30 °C / 60 % RH
MSL 2	1 year	30 °C / 60 % RH
MSL 1	Unlimited	30 °C / 85 % RH

8.3 UQFN Handling

Manual handling of UQFN packages should be reduced to the absolute minimum. In cases where it is still necessary, a vacuum pick-up tool should be used. In extreme cases plastic tweezers could be used, but metal tweezers are not acceptable, since contact may easily damage the silicon chip.

8.4 Soldering Information

Refer to the IPC/JEDEC standard J-STD-020 for relevant soldering information. This document can be downloaded from <http://www.jedec.org>.

9. Ordering Information

The ordering number consists of the part number followed by a suffix indicating the packing method. For details and availability of OTP variants, please consult your Renesas [local sales representative](#).

Table 21. Ordering Information

Part Number	Package Description (RoHS Compliant)	Pkg. Dwg. #	Carrier Type	Temperature Range
DA9281-xxAT1	40 lead, 5 x 5 QFN	40-QFN	Tray, 490	-40 °C to +85 °C
DA9281-xxAT2			Reel, 5 k	
DA9281-xxATC			Reel, 1 k	

Part Number Legend:

xx: OTP variant

10. MPU Compatibility

[Table 22](#) shown the list of MPU devices that are compatible with the specific variant.

Table 22. Target MPU

Feature	OTP-01	-	-	-	-	-
Target MPU	RZ/G2L RZ/V2L	-	-	-	-	-

11. Application Information

The following recommended components are references selected from requirements of a typical application.

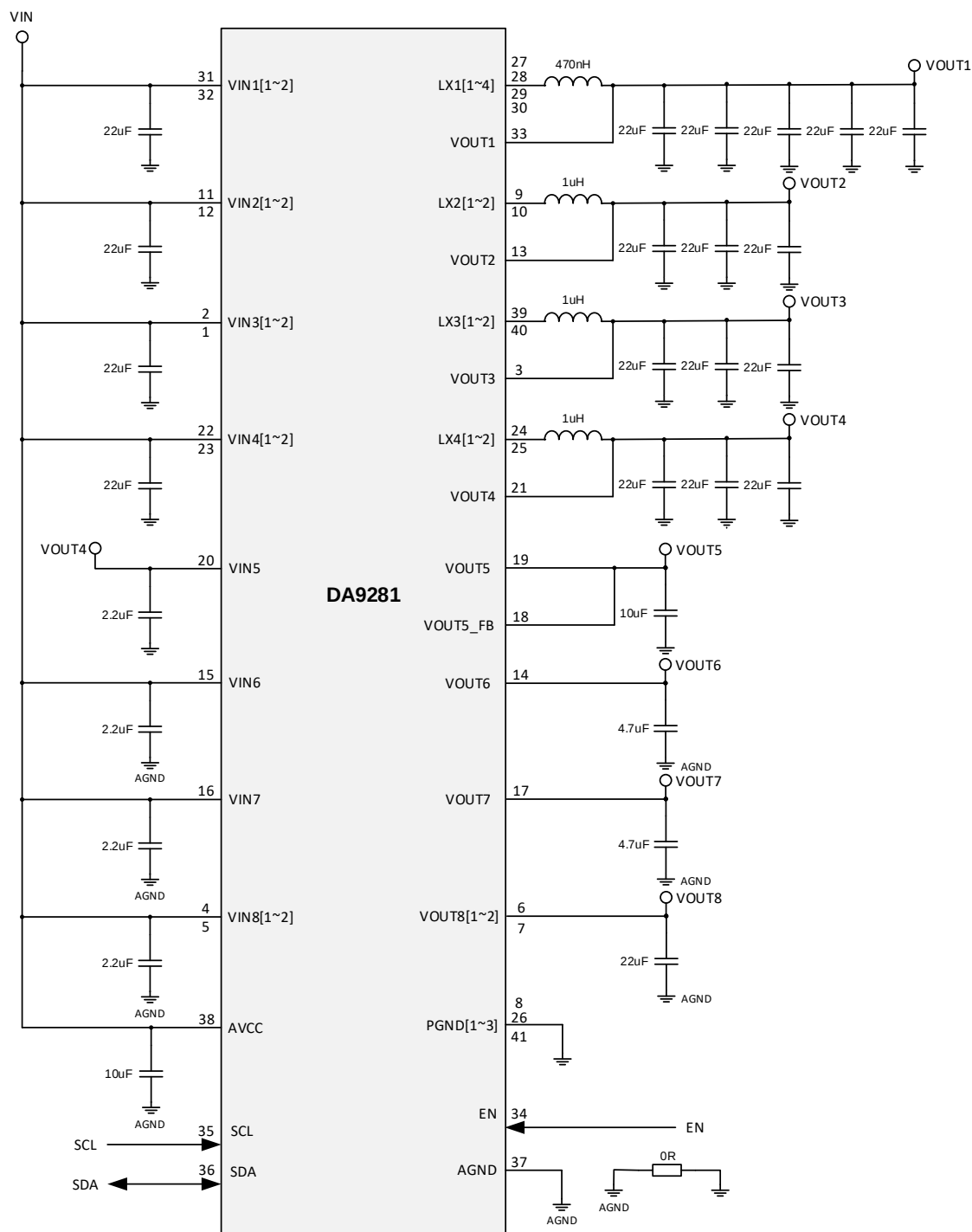


Figure 41. Application Diagram

11.1 Capacitor Selection

Ceramic capacitors are used as bypass capacitors at all V_{INx} and output rails. When selecting a capacitor, especially for types with high capacitance at smallest physical dimension, the DC bias characteristic has to be taken into account.

Table 23. Recommended Capacitor Types

Application	Value	Size	Temp. Char.	Tol. (%)	V-Rate	Type
V_{IN1} , V_{IN2} , V_{IN3} , V_{IN4} input bypass	1x 22 μ F	0805	X5R	± 20	16 V	Murata GRM21BR61C226ME44L
V_{IN5} , V_{IN6} , V_{IN7} , V_{IN8} input bypass	1x 2.2 μ F	0603	X7R	± 10	10 V	TDK C1608X7R1A225K080AC
V_{OUT1} output bypass	5x 22 μ F	0805	X5R	± 20	16 V	Murata GRM21BR61C226ME44L
V_{OUT2} , V_{OUT3} , V_{OUT4} , output bypass	3x 22 μ F	0805	X5R	± 20	16 V	Murata GRM21BR61C226ME44L
V_{OUT5} output bypass	1x 10 μ F	0603	X5R	± 10	10 V	Murata GRM188R61A106KE69D
				± 20		Murata GRM188R61A106ME69#
V_{OUT6} , V_{OUT7} output bypass	1x 4.7 μ F	0603	X5R	± 10	16 V	Murata GRM188R61C475KAAJD
						Murata GRM188R61C475KE11#
V_{OUT8} output bypass	1x 22 μ F	0805	X5R	± 20	16 V	Murata GRM21BR61C226ME44L
AVCC bypass	1x 10 μ F	0603	X5R	± 10	10 V	Murata GRM188R61A106KE69D

11.2 Inductor Selection

Inductors should be selected based on the following parameters:

- Rated maximum current
Usually a coil provides two current limits: ISAT specifies the maximum current at which the inductance drops by 30 % of the nominal value, and IMAX is defined by the maximum power dissipation and is applied to the effective current.
- DC resistance
Critical for the converter efficiency and should therefore be minimized.

Fully shielded inductors are highly recommended to use. The typical recommended output inductances are 0.47 μ H for CH1 and 1.0 μ H for CH2, CH3 and CH4. Use of larger output inductance degrades the load transient performance of the buck converters.

Table 24. Recommended Inductor Types

Application	Value (μ H)	Size (mm)	I_{MAX} (DC) (A)	I_{SAT} (A)	Tol. (%)	DC Resistance (m Ω)	Type
LX ₁ output inductor	0.47	2.5 x 2.0 x 1.2	4.9	6.7	± 20	23	Murata DFE252012F-R47M=P2
LX ₂ , LX ₃ , LX ₄ output inductor	1.0	2.5 x 2.0 x 1.2	3.3	4.7	± 20	40	Murata DFE252012F-1R0M=P2

A. ECAD Design Information

This appendix contains information that supports the development of the PCB ECAD model for this device. It is intended to be used by PCB designers.

A.1 Part Number Indexing

Orderable Part Number	Number of Pins	Package Type	Package Code/POD Number
DA9281-xxAT1	40	QFN	QW0040AB/PSC-5138-01
DA9281-xxAT2	40	QFN	QW0040AB/PSC-5138-01
DA9281-xxATC	40	QFN	QW0040AB/PSC-5138-01

1. xx: OTP variant

A.2 Symbol Pin Information

A.2.1 40-QFN

Pin Number	Primary Pin Name	Primary Electrical Type	Alternate Pin Name(s)
1	VIN3	Power	-
2	VIN3	Power	-
3	VOUT3	Input	-
4	VIN8	Power	-
5	VIN8	Power	-
6	VOUT8	Power	-
7	VOUT8	Power	-
8	PGND	Power	-
9	LX2	Power	-
10	LX2	Power	-
11	VIN2	Power	-
12	VIN2	Power	-
13	VOUT2	Input	-
14	VOUT6	Power	-
15	VIN6	Power	-
16	VIN7	Power	-
17	VOUT7	Power	-
18	VOUT5_FB	Input	-
19	VOUT5	Power	-
20	VIN5	Power	-
21	VOUT4	Input	-
22	VIN4	Power	-
23	VIN4	Power	-
24	LX4	Power	-
25	LX4	Power	-
26	PGND	Power	-
27	LX1	Power	-

Pin Number	Primary Pin Name	Primary Electrical Type	Alternate Pin Name(s)
28	LX1	Power	-
29	LX1	Power	-
30	LX1	Power	-
31	VIN1	Power	-
32	VIN1	Power	-
33	VOUT1	Input	-
34	EN	Input	-
35	SCL	Input	-
36	SDA	I/O	-
37	AGND	Power	-
38	AVCC	Power	-
90	LX3	Power	-
40	LX3	Power	-
EPAD41	PGND	Power	-

A.3 Symbol Parameters

Orderable Part Number	Interface	Max Junction Temperature (Tj)	Max Input Voltage	Min Input Voltage	Max Operating Temperature	Min Operating Temperature	Max Output Current	Max Output Voltage	Min Output Voltage	Mounting Type	Qualification	RoHS	Switching Frequency
DA9281-xxAT1	I2C	+150 °C	5.5 V	4.5 V	+85 °C	-40 °C	5 A	3.6 V	0.8 V	SMD	Industrial	Compliant	2 MHz
DA9281-xxAT2	I2C	+150 °C	5.5 V	4.5 V	+85 °C	-40 °C	5 A	3.6 V	0.8 V	SMD	Industrial	Compliant	2 MHz
DA9281-xxATC	I2C	+150 °C	5.5 V	4.5 V	+85 °C	-40 °C	5 A	3.6 V	0.8 V	SMD	Industrial	Compliant	2 MHz

A.4 Footprint Design Information

A.4.1 40-QFN

IPC Footprint Type	Package Code/ POD Number	Number of Pins
QFN	QW0040AB/PSC-5138-01	40

Description	Dimension	Value (mm)	Diagram
Minimum body span (vertical side)	Dmin	4.95	Bottom View
Maximum body span (vertical side)	Dmax	5.05	
Minimum body span (horizontal side)	Emin	4.95	
Maximum body span (horizontal side)	Emax	5.05	
Minimum Lead Width	Bmin	0.15	
Maximum Lead Width	Bmax	0.25	
Minimum Lead Length	Lmin	0.25	
Maximum Lead Length	Lmax	0.35	
Maximum Height	Amax	0.90	
Minimum Standoff Height	A1min	0	
Minimum Lead Thickness	cmin	0.15	Side View
Maximum Lead Thickness	cmax	0.25	
Number of pins (vertical side)	PinCountD	10	
Number of pins (horizontal side)	PinCountE	10	
Distance between the center of any two adjacent pins (vertical side)	PitchD	0.40	
Distance between the center of any two adjacent pins (horizontal side)	PitchE	0.40	
Location of pin 1; S2 = corner of D side (top left), C1 = center of E side(center).	Pin1	S2	
Thermal pad Chamfer. If not present give hyphen (-).	CH	0.35	
Minimum thermal pad size (vertical side)	D2min	3.74	
Maximum thermal pad size (vertical side)	D2max	3.84	
Minimum thermal pad size (horizontal side)	E2min	3.74	
Maximum thermal pad size (horizontal side)	E2max	3.84	

Recommended Land Pattern			
Description	Dimension	Value (mm)	Diagram
Distance between left pad toe to right pad toe (horizontal side)	ZE	5.30	PCB Top View
Distance between top pad toe to bottom pad toe (vertical side)	ZD	5.30	
Distance between left pad heel to right pad heel (horizontal side)	GE	4.40	
Distance between top pad heel to bottom pad heel (vertical side)	GD	4.40	
Pad Width	X	0.20	
Pad Length	Y	0.45	



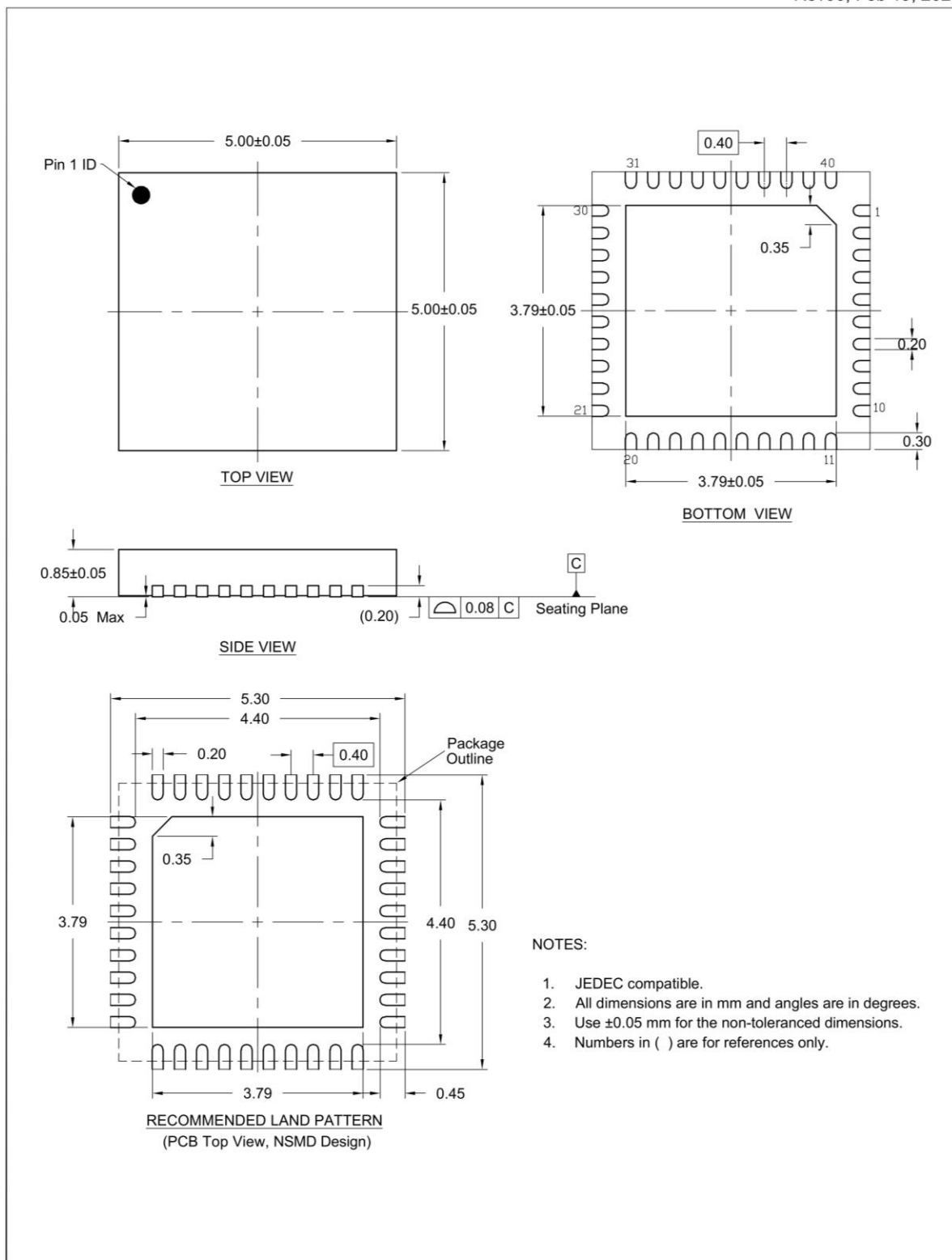
Package Outline Drawing

PSC-5138-01

QW0040AB

40-QFN 5.0 x 5.0 x 0.85 mm Body, 0.40 mm Pitch

Rev00, Feb 19, 2025



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